

SAF7741HV

Dual IF car radio and audio DSP (N1F)

Rev. 07 — 28 April 2010

1. General description

The SAF7741HV is a combined Intermediate-Frequency (IF) car radio and audio Digital Signal Processor (DSP) with several powerful cores integrated onto a single device. It combines analog IF input, digital radio and audio processing, sample-rate converters and digital and analog audio output to enhance listening clarity and noise suppression while reducing multipath channel effect.

The SAF7741 offers user-specific functions which can be configured to match the software platform required by the systems of individual car-radio manufacturers, thus providing a high level of product differentiation. It is equipped to work with the TEF7000 and TEF6730 integrated tuners for analog and digital AM/FM decoding and sound processing

The SAF7741HV consists of two main processing blocks; one for radio and the other for audio. These blocks demodulate either the IF or the low-IF tuner output, delivering digital audio to internal Digital-to-Analog Converters (DACs). In addition to the main blocks there are a number of interfaces and dedicated sub-circuits.

1.1 Radio processing

The IF radio block interfaces to the front-end tuner chips and supports either a so-called low-IF frequency (of 60 kHz or 300 kHz) or an IF frequency of 10.7 MHz. Two tuner interfaces are supported, each of which is suitable for analog Frequency-Modulated/Amplitude-Modulated and Weatherband (FM/AM/WX) radio reception as well as reception of encoded digital signals such as HD Radio and Digital Radio Mondiale (DRM).

Signals received from the tuner front-end chips are digitized with integrated Intermediate-Frequency Analog-to-Digital Converters (IFADCs). The resulting digital signals are then down-sampled, error-corrected and filtered in the digital domain to be suitable for further radio and audio processing by the DSPs.

The low-IF interface to the tuner chip combined with the high level of integration allows cost-effective implementation of the entire tuner/DSP application on a main radio Printed Circuit Board (PCB).

1.2 Audio processing

The audio processing block receives either external digital signals, or analog signals which are then digitized by the integrated ADCs. Together with the internal radio audio signals these inputs are available for further audio processing such as equalization, tone control and volume control. The output signals of the audio processing block are provided in digital format on the Host IIS outputs and in analog format on the DAC outputs.



2. Features

2.1 Hardware features

SAF7741HV hardware is configured by firmware and host software to meet specific customer requirements. The firmware is defined by the Read-Only Memory (ROM) code associated with each DSP.

Remark: The list below describes the maximum hardware configuration. Customers should consult with NXP to identify the best method of supporting their own particular requirements.

- Two IF data-paths of either 2 × IF 10.7 MHz or 2 × low IF 300 kHz input Remark: The combination of 1 x IF and 1 x low IF is not supported.
- Two 5th order Sigma-Delta (ΣΔ) IF ADCs for FM/AM/WB (Weather-band) and digital radio at either IF = 10.7 MHz or low IF = 300 kHz
- IF signal quadrature-mixing and down-sampling with signal level generation
- Automatic Gain Control (AGC) of the radio front-end chip in three steps (6 dB for each step) for the TEF6730 tuner and seven steps (6 dB for each step) for the TEF7000 tuner
- AGC control of the TEF6730 tuner front-end PIN diodes, with an analog signal via the Radio General-Purpose DAC (RGP DAC) output: one DAC for each radio data path
- Integrated IF filter with bandwidth of 100 kHz or 400 kHz
- Two wideband outputs for external digital radio decoding; one output for each data-path
- Two Radio Data System (RDS) decoders
- Five bit-stream, 3rd order audio, $\Sigma\Delta$ ADCs with an anti-aliasing broadband input-filter
- Eight configurable analog inputs (differential/stereo/mono) connected to any of the five ADCs using an analog switchbox
- Dedicated DSP for the Sample Rate Converter (SRC)
- Audio Host Inter-IC Sound (IIS) Input/Output (I/O) port, with eight/ten outputs and eight inputs with an option for slaving the DSP to an external master sample-rate
- Audio Host IIS Bit-Clock (BCK) and Word-Size (WS) available simultaneously at full-rate and half-rate
- Four independent IIS inputs and two independent digital Sony/Philips Digital Interface Format (SPDIF) inputs also configurable for Digital Versatile Disc/Digital Video Device (DVD) multi-channel data inputs
- Radio Host IIS master with separate data in and out lines
- IIS output with buffer for eight samples for radio applications
- WatchDog (WDOG) to monitor execution of the DSP main software loop
- Phase-Lock Loop (PLL) to generate the DSP clock from the oscillator crystal
- PLL to generate the audio reference sample-rate clock
- Internal voltage regulator for the 1.8 V supply
- I²C (Inter-IC Communication) bus-controlled
- Possibility of powering down unused blocks to reduce power dissipation
- Qualified in accordance with AEC-Q100

2.2 Software Features

The following software features are available for the SAF7741HV:

- Improved FM weak-signal processing
- Integrated 19 kHz Multiplexed (MPX) filter and de-emphasis
- Electronic adjustment of FM/AM level and FM channel separation
- Variable IF bandwidth. This is controlled partly by the DSP software and depends on the quality of the reception
- Selective IF bandwidth for wideband FM, FM Weatherband and AM
- Variable IF bandwidth on FM, dependent on the adjacent channel interference
- Digital stereo decoder for FM and AM
- Advanced digital Interference Absorption Circuit (IAC) for FM and AM
- Digital Automatic Frequency Control (AFC)
- RDS demodulation
- Pause detection for RDS updates with audio mute during RDS updates
- Baseband audio processing (treble, bass, balance, fader and volume)
- Maximum of five audio SRCs
- Dynamic loudness or bass boost
- Audio level meter
- Compact Disc (CD) dynamics compressor/expander
- Improved AM processing with soft mute, high cut control, 6th order low-pass filtering and AM audio IAC
- Soft audio mute
- Extended chime functions
- Signal level, noise and multi-path detection for AM/FM signal quality information
- AM audio AGC
- AGC click suppression in AM mode

3. Applications

The SAF7741HV is designed for use in high-performance car radio systems.

4. Ordering information

Table 1.Ordering information

| Type Number | Package | | | |
|-------------|----------|--|---------|--|
| | Name | Description | Version | |
| SAF7741HV | HLQFP144 | 144 leads; plastic thermal enhanced low profile quad flat package; exposed die pad | N115F | |

5. Block diagram

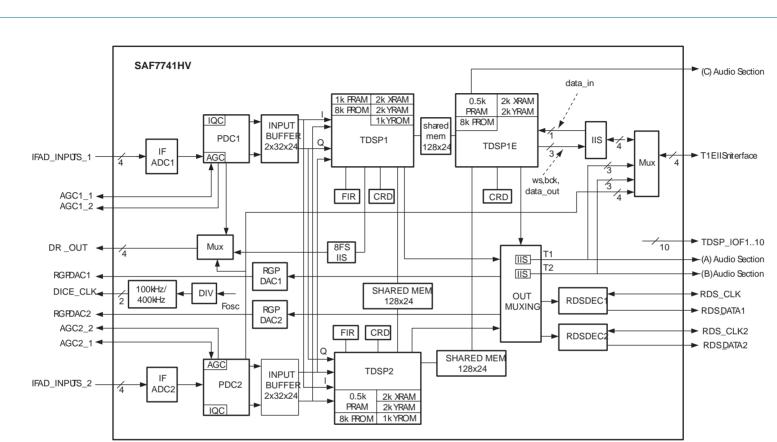


Fig 1. Block diagram of SAF7741HV radio section

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5.

Product data sheet

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SAF7741HV Dual IF car radio and audio DSP (N1F)

SAF7741HV SD_HOST_ SD_HOST_OUT1..4 4 5 IN1..5 SELECTOR BCK HOST AIN0 R ANALOG SOURCE ➤ WS_HOST AD1 AIN0_L ♦ dac_fl AD2 DAC FL AIN1 R -DAC t dac fr AIN1_L -DAC DAC_FR AD3 dac_rl AIN2 R DAC DAC RL t dac rr AIN2_L AD4 ADSP DAC → DAC_RR AUDIO AIN3 dac center DAC_CENTER PROCESSING DAC ŧ AD5 t dac_subw AIN4 DAC DAC SUBW IN1 3 D IN2 3 IN3 G S 3 IN4 3 Ť Т DIGITAL A E L C SDSP ADSP_IOF4..11 SPDIF SPDIF1_IN1 -8 BITSLICER DECODER 256 PRAM s 0 Ċ 1280 YRAM SCL SDA 800XRAM DIGITAL L I 1024YROM 7168PROM 2816 XRAM SPDIF1 IN2 BITSLICER SPDIF 120 WATCHDOG R 9216 PROM SCL_DICE SDA_DICE DECODER (A) RADIO F SECTION dsp_clk (B) RADIO DSP Fosc PLL SECTION FS_SYS D PLL WS_HOST AUDIO FOSC osc 14 DIV FSREF_RADIO FSREF_AUDIO (C) RADIO ADSP-TDSP1E REGULATOR 4 SECTION INTERFACE Fig 2. Block diagram of SAF7741HV audio section

6. Pinning information

6.1 Pinning

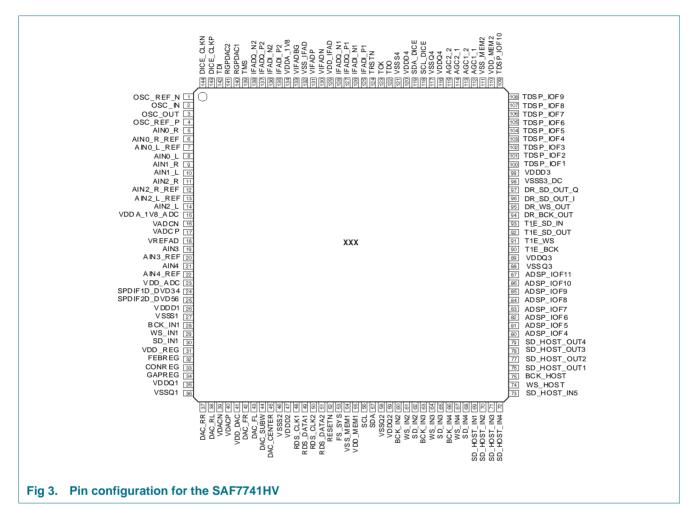


Table 2.Pin allocation table

| Pin Name | Pin Number | Description | Pin Type |
|------------|---------------|---|----------|
| OSC_REF_N | 1 | Ground reference for oscillator, PLLs and tuner clock generator | VSSCO |
| OSC_IN | 2 | Crystal oscillator input | apio |
| OSC_OUT | 3 | Crystal oscillator output | apio |
| OSC_REF_P | 4 | 1.8 V reference supply for oscillator, PLLs and tuner clock generator | vddco |
| AIN0_R | 5 | Right channel analog audio input 0 | apio |
| AIN0_R_REF | 6 | Right common mode reference audio input 0 | apio |
| AIN0_L_REF | 7 | Left common mode reference audio input 0 | apio |
| AIN0_L | 8 | Left channel analog audio input 0 | apio |
| AIN1_R | 9 | Right channel analog audio input 1 | apio |
| AIN1_L | 10 | Left channel analog audio input 1 | apio |
| AIN2_R | 11 | Right channel analog audio input 2 | apio |

Table 2.

Pin allocation table ... continued Pin Name Pin Description Pin Type Number AIN2_R_REF Right common mode reference audio input 2 12 apio AIN2_L_REF 13 Left common mode reference audio input 2 apio AIN2 L 14 Left channel analog audio input 2 apio VDDA_1V8_ADC 15 1.8 V supply for ADC vddco Ground reference for audio ADCs and RGPDACs VADCN 16 apio Positive reference voltage for Audio ADCs and RGPDACs VADCP 17 apio VREFAD Common mode reference voltage ADCs 18 apio AIN3 19 Analog audio input 3 apio 20 AIN3 REF Common mode reference audio input 3 apio 21 AIN4 Analog audio input 4 apio AIN4 REF 22 Common mode reference audio input 4 apio VDD ADC 23 3.3 V supply for audio ADCs vddco SPDIF_IN1 24 Input 1 SPDIF analog / input DVD-A channels 3 and 4 [1] apio SPDIF_IN2 25 Input 2 SPDIF analog / input DVD-A channels 5 and 6 [1] apio VDDD1 26 1.8 V positive supply (digital core) vddi 27 VSSS1 Ground supply (digital core) vssis BCK_IN1 28 Inter-IC Sound (I²S) source 1 Bit Clock input bpts5ptpht5v WS IN1 29 I²S source 1 Word Select input bpts5ptpht5v I²S source 1 data input/input DVD-A channels 1 and 2 SD_IN1 30 bpts5ptpht5v VDD_REG 31 3.3 V supply for regulator vddco FEBREG 32 Feedback input monitoring the 1.8 V apio 33 Control output for external Positive-channel Metal Oxide Semiconductor CONREG apio (PMOS) transistor GAPREG 34 Decoupling for regulator bandgap voltage apio VDDQ1 35 3.3 V positive supply (peripheral cells) vdde VSSQ1 36 Ground supply (peripheral cells) vsse DAC_RR 37 Audio output for the rear-right speaker apio 38 Audio output for the rear-left speaker DAC RL apio VDACN 39 Ground reference voltage for the Audio DACs (ADAC) apio VDACP 40 Positive reference voltage for the Audio DACs (ADAC) apio VDD DAC 41 3.3 V supply for the Audio DACs (ADAC) vddco DAC FR 42 Audio output for the front-right speaker apio DAC_FL 43 Audio output for the front-left speaker apio DAC SUBW 44 Audio output for the sub-woofer apio DAC CENTER 45 Audio output for the centre speaker apio VSSS2 46 Ground supply (digital core) vssis VDDD2 47 1.8 V positive supply (digital core) vddi RDS CLK1 48 RDS bit clock (CLK) output 1/RDS external clock input 1 bpts5ptpht5v RDS_DATA1 49 RDS data output 1 bpts5ptpht5v RDS_CLK2 50 RDS bit clock output 2/RDS external clock input 2 bpts5ptpht5v

Table 2. Pin allocation table ... continued **Pin Name** Pin Description Pin Type Number RDS_DATA2 51 RDS data output 2 bpts5ptpht5v RESETN 52 General reset of chip (active low) bpts5ptpht5v 53 bpts10thdt5v FS SYS Fs system clock in/output 54 Ground supply (digital core) VSS_MEM1 vssi VDD_MEM1 55 1.8 V positive supply (memories) vddcobf Serial clock input I²C bus iic3m4sclt5v SCL 56 SDA 57 Serial data input/output I²C bus iic3m4sdat5v Ground supply (peripheral cells) VSSQ2 58 vsse VDDQ2 59 3.3 V positive supply (peripheral cells) vdde 60 IIS source 2 Bit Clock input BCK_IN2 bpts5ptpht5v WS_IN2 61 IIS source 2 Word Select input bpts5ptpht5v SD IN2 62 IIS source 2 data input bpts5ptpht5v IIS source 3 Bit Clock input BCK_IN3 63 bpts5ptpht5v WS_IN3 64 IIS source 3 Word Select input bpts5ptpht5v SD IN3 65 IIS source 3 data input bpts5ptpht5v BCK_IN4 66 IIS source 4 Bit Clock input bpts5ptpht5v WS_IN4 67 IIS source 4 Word Select input bpts5ptpht5v SD IN4 68 IIS source 4 data input/input SPDIF 1 digital bpts5ptpht5v Host I²S 1 data input SD_HOST_IN1 69 bpts5ptpht5v SD_HOST_IN2 70 Host I²S 2 data input bpts5ptpht5v SD_HOST_IN3 71 Host I²S 3 data input bpts5ptpht5v 72 Host I²S 4 data input SD_HOST_IN4 bpts5ptpht5v SD_HOST_IN5 73 Host I²S 5 data input bpts5ptpht5v WS_HOST 74 Host I²S Word Select output/input bpts10thdt5v 75 BCK HOST Host I²S Bit Clock output/input bpts10thdt5v SD_HOST_OUT1 76 Host I²S 1 data output bpts10thdt5v SD_HOST_OUT2 77 Host I²S 2 data output bpts10thdt5v SD_HOST_OUT3 78 Host I²S 3 data output bpts10thdt5v SD_HOST_OUT4 79 Host I²S 4 data output bpts10thdt5v ADSP_IOF4 80 Audio DSP (ADSP) general purpose I/O flag 4 bpts5ptpht5v ADSP_IOF5 81 ADSP general purpose I/O flag 5 bpts5ptpht5v ADSP_IOF6 82 Audio/SCR DSP general purpose I/O flag 6 bpts5ptpht5v ADSP_IOF7 83 Audio/SRC DSP general purpose I/O flag 7 bpts5ptpht5v ADSP_IOF8 84 Audio/SRC DSP general purpose I/O flag 8 bpts5ptpht5v ADSP_IOF9 85 Audio/SRC DSP general purpose I/O flag 9 bpts5ptpht5v ADSP_IOF10 86 Audio/SRC DSP general purpose I/O flag 10 bpts5ptpht5v ADSP_IOF11 87 Audio/SRC DSP general purpose I/O flag 11 bpts5ptpht5v VSSQ3 88 Ground supply (peripheral cells) vsse VDDQ3 89 3.3 V positive supply (peripheral cells) vdde T1E_BCK 90 Tuner I²S BCK output / digital radio interface 2 bit clock output bpts10thdt5v

| Table 2. Pin allocation tablecontinued | | | |
|--|---------------|---|--------------|
| Pin Name | Pin Number | Description | Pin Type |
| T1E_WS | 91 | Tuner I ² S WS output / digital radio interface 2 word-select output | bpts10thdt5v |
| T1E_SD_OUT | 92 | Tuner I^2S Serial data output / Serial data output digital radio interface 2 word select signal | bpts10thdt5v |
| T1E_SD_IN | 93 | Tuner I ² S Serial data input / Serial data output digital radio interface 2 Q-signal | bpts10thdt5v |
| DR_BCK_OUT | 94 | Digital radio interface 1 bit clock output | bpts10thdt5v |
| DR_WS_OUT | 95 | Digital radio interface 1 word-select output | bpts10thdt5v |
| DR_SD_OUT_I | 96 | Serial data output digital radio interface 1 I-signal | bpts10thdt5v |
| DR_SD_OUT_Q | 97 | Serial data output digital radio interface 1 Q-signal | bpts10thdt5v |
| VSSS3_DC | 98 | Digital core DC ground connection | vssis |
| VDDD3 | 99 | 1.8 V positive supply (digital core) | vddi |
| TDSP_IOF1 | 100 | Tuner DSP (TDSP) general purpose I/O flag 1 | bpts5ptpht5v |
| TDSP_IOF2 | 101 | Tuner DSP general purpose I/O flag 2 | bpts5ptpht5v |
| TDSP_IOF3 | 102 | Tuner DSP general purpose I/O flag 3 | bpts5ptpht5v |
| TDSP_IOF4 | 103 | Tuner DSP general purpose I/O flag 4 | bpts5ptpht5v |
| TDSP_IOF5 | 104 | Tuner DSP general purpose I/O flag 5 | bpts5ptpht5v |
| TDSP_IOF6 | 105 | Tuner DSP general purpose I/O flag 6 | bpts5ptpht5v |
| TDSP_IOF7 | 106 | Tuner DSP general purpose I/O flag 7 | bpts5ptpht5v |
| TDSP_IOF8 | 107 | Tuner DSP general purpose I/O flag 8 | bpts5ptpht5v |
| TDSP_IOF9 | 108 | Tuner DSP general purpose I/O flag 9 | bpts5ptpht5v |
| TDSP_IOF10 | 109 | Tuner DSP general purpose I/O flag 10 | bpts5ptpht5v |
| VDD_MEM2 | 110 | 1.8 V positive supply (memories) | vddco |
| VSS_MEM2 | 111 | Ground supply (digital core) | vssi |
| AGC1_1 | 112 | Command input from TEF7000 connected to IFAD1 / Least Significant Bit (LSB) gain control output to TEF6730 tuner connected to IFAD1 | bpts5ptpht5v |
| AGC1_2 | 113 | Request output to TEF7000 tuner connected to IFAD1 / Most Significant Bit (MSB) gain control output to TEF6730 tuner connected to IFAD1 | bpts5ptpht5v |
| AGC2_1 | 114 | Command input from TEF7000 connected to IFAD2 / Least Significant Bit (LSB) gain control output to TEF6730 tuner connected to IFAD2 | bpts5ptpht5v |
| AGC2_2 | 115 | Request output to TEF7000 tuner connected to IFAD2 / Most Significant Bit (MSB) gain control output to TEF6730 tuner connected to IFAD2 | bpts5ptpht5v |
| VDDQ4 | 116 | 3.3 V positive supply (peripheral cells) | vdde |
| VSSQ4 | 117 | Ground supply (peripheral cells) | vsse |
| SCL_DICE | 118 | SCL output of the tuner I ² C bus | iic3m4sclt5v |
| SDA_DICE | 119 | SDA input/output of the tuner I ² C bus | iic3m4sdat5v |
| VDDD4 | 120 | 1.8 V positive supply (digital core) | vddi |
| VSSS4 | 121 | Ground supply (digital core) | vssis |
| TDO | 122 | JTAG Test control data output | bpts5ptpht5v |
| ТСК | 123 | JTAG Test clock | bpts5ptpht5v |
| TRSTN | 124 | JTAG Test reset, active low | bpts5ptpht5v |
| IFADI_P1 | 125 | Positive phase of the first differential IF I input | aprf3v3 |
| IFADI_N1 | 126 | Negative phase of the first differential IF I input | aprf3v3 |

Table 2. Pin allocation table ...continued

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Dual IF car radio and audio DSP (N1F)

| Table 2. Pin a | Illocation tab | lecontinued | |
|----------------|----------------|--|--------------|
| Pin Name | Pin Number | Description | Pin Type |
| IFADQ_P1 | 127 | Positive phase of the first differential IF Q input | aprf3v3 |
| IFADQ_N1 | 128 | Negative phase of the first differential IF Q input | aprf3v3 |
| VDD_IFAD | 129 | 3.3 V supply for IF ADCs and RGPDACs | vddco |
| VIFADN | 130 | Ground reference voltage for IF ADCs | apio |
| VIFADP | 131 | Decoupling for IF ADCs positive reference voltage | apio |
| VSS_IFAD | 132 | Ground supply for IF ADCs and RGPDACs | VSSCO |
| VIFADBG | 133 | Decoupling for IF ADCs bandgap voltage | apio |
| VDDA_1V8 | 134 | 1.8 V supply for IFADC and Audio ADCs | vddco |
| IFADI_P2 | 135 | Positive phase of the second differential IF I input | aprf3v3 |
| IFADI_N2 | 136 | Negative phase of the second differential IF I input | aprf3v3 |
| IFADQ_P2 | 137 | Positive phase of the second differential IF Q input | aprf3v3 |
| IFADQ_N2 | 138 | Negative phase of the second differential IF Q input | aprf3v3 |
| TMS | 139 | JTAG Test mode select | bpts5ptpht5v |
| RGPDAC1 | 140 | RGP DAC 1 output | apio |
| RGPDAC2 | 141 | RGP DAC 2 output | apio |
| TDI | 142 | JTAG Test control data input | bpts5ptpht5v |
| DICE_CLKP | 143 | 100 kHz/400 kHz clock reference output to TEF6730/TEF7000 tuner (positive) | apio |
| DICE_CLKN | 144 | 100 kHz/400 kHz clock reference output to TEF6730/TEF7000 tuner (negative) | apio |

[1] The maximum input voltage is 3.3 volts.

6.2 Pin description

Pad name description Table 3.

| Pad Name | Description |
|--------------------|---|
| IICT5V | |
| iic3m4sdat5v | IIC pad: 5 V-tolerant; data signal |
| iic3m4sclt5v | IIC pad: 5 V-tolerant; clock signal |
| IOT5V | |
| bpts5ptpht5v | Bi-directional pad; plain input; 3-state output; SSO control; TTL with programmable hysteresis; programmable pull-up and pull-down, repeater; 5 V- tolerant |
| bpts10thdt5v | Bi-directional pad; plain input ; 3-state output; 10 ns slew-rate control; TTL with hysteresis; pull-down; 5 V-tolerant |
| IO3V3 | |
| apio | Analog pad; analog input/output for RF applications; ESD diode to VDD supply |
| aprf | Analog pad; analog input/output for RF applications; ESD diode to VDDE supply |
| aprf3v3 | Analog pad; analog supply for high-voltage application; high trigger-voltage ESD protection |
| IO3V3 (supply) | |
| vddco | VDD pad connected to CORE VDD |
| vddcobf | VDD pad connected to CORE VDD with BigFET protection |
| vdde | VDD pad connected to external (noisy) VDD supply rail |
| SAF7741_7 | © NXP B.V. 2010. All rights rese |
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| Table 3. Pac | a name descriptioncontinued |
|--------------|--|
| Pad Name | Description |
| vddi | VDD pad connected to CORE VDD and internal VDD supply rail in I/O ring |
| vssi | VSS pad connected to CORE VSS and internal VSS supply rail in I/O ring |
| vsse | VSS pad connected to external (noisy) VSS supply rail |
| vssis | VSS pad connected to CORE VSS, internal VSS supply rail in I/O ring and substrate rail in I/O ring |
| VSSCO | VSS pad connected to CORE VSS |

7. Functional description

7.1 Radio subsystem

The complete radio system is able to receive FM, AM, Weatherband, RDS and FM/AM digital radio. The SAF7741HV radio section will incorporate the following features (see <u>Figure 1</u>):

- Two IFADCs to digitize the incoming analog IF signals from the tuner(s)
- Two Primary Decimation Chains (PDCs) for analog and digital radio reception, including digital mixing to Zero IF (ZIF)
- Software-based radio functionality running on one or more DSPs depending on the features set and dual or single tuner usage

The IFADC digitizes the incoming Near-Zero Intermediate Frequency (NZIF) signals. The IFADC is a baseband $\Sigma\Delta$ ADC.

The PDC decimates the incoming data stream by a factor of 128 before passing it to the software radio for processing.

For digital radio reception the PDC decimates the incoming data stream by 64 before it is forwarded to the external co-processor.

The software radio consists of three Tuner DSPs: TDSP1, TDSP2 and TDSP1E. All three TDSPs have a basically identical structure, but TDSP1 and TDSP2 are extended with:

- A Finite Impulse Response (FIR) filter
- CORDIC (COordinate Rotation DIgital Calculation) Rotate and De-rotate (CRD)

TDSP1E is extended with a CRD only. Each FIR (controlled by the TDSP) is used for variable bandwidth control and for the Polar-to-Rectangular (P->R), Rectangular-to-Polar (R->P) and DIV conversions that will be used for demodulation. Added to this block is a 2LOG(LD(x)) function.

In addition, a Radio General-Purpose DAC (RGPDAC) and an RDS decoder are included for each tuner channel.

The SAF7741HV chip is capable of handling full dual radio. Depending on the firmware, several such configurations are possible:

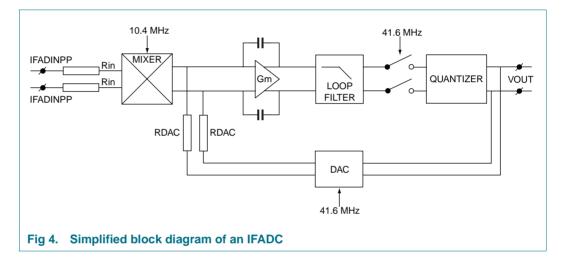
• Dual radio with two stereo-audio output channels. The attainable performance depends on the DSP tuner firmware. The available feature set is less than that for one-channel radio

- Dual tuner, which offers antenna, phased-array or MPX diversity
- · Single tuner on the smallest possible hardware set: preferably one DSP

7.1.1 IFADCs

For each tuner path two fully differential $\Sigma\Delta$ IFADCs are used for the I and Q paths. For each IFADC two fully differential input nodes are fed with a 300 kHz input signal. This design provides good suppression of even harmonics. The noise is shaped by a 5th order loop filter to get sufficient resolution in the band of interest, and for complex filtering the input signal of the I and Q paths has a 90° phase shift.

The IFADCs are sampled by a 41.6 MHz clock. The output is a 1-bit bitstream signal with a frequency of 41.6 MHz (see Figure 4).



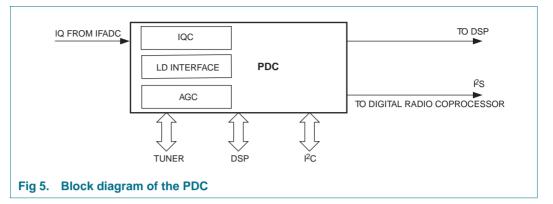
7.1.1.1 TEF6730 tuner compatibility mode

In this mode the IF input signal is 10.7 MHz differential. The mixer is in front of the IFADC, and this converts the input signal down to 300 kHz using a quadrature 10.4 MHz square wave. The 300 kHz down-converted signal is then fed to the IFADCs as I and Q signals.

Switching to TEF6730 tuner compatibility mode is performed via the I²C interface and is only available to the microprocessor.

7.1.2 Primary decimation chain

The PDC (see <u>Figure 5</u>) decimates the incoming sample rate from the IFADC, shifts the signal to baseband and applies Amplitude Gain Control (AGC) step compensation, linear AGC correction and IQ Correction (IQC).



The PDC decimates the incoming signal by 16 before shifting it to the baseband and creating two paths: 'wanted' and 'image'. After another decimation by two, the AGC stage takes place to compensate for the tuner gain-reduction steps. The linear gain control stage makes sure that there is maximum use of the dynamic range. After another decimation by two the IQC stage takes place to compensate for imperfections in the analog mixer of the tuner by measuring and correcting possible aliases between the wanted and image signals. The PDC settings allow for different IF bandwidth corrections and for local oscillator swap of the TEF7000. Communication between the tuner and SAF7741HV uses the proprietary two-line LD interface for AGC, injection-mode and bandwidth settings.

The PDC has two data outputs: one parallel inteface to the TDSPs and one I²S-like interface to the external digital radio co-processor.

7.1.2.1 PDC Input

The PDC input is a complex bit stream from the 5th order converter. The I and Q bit streams each have a sample rate of 41.6 MSa/s.

7.1.2.2 Input decimation

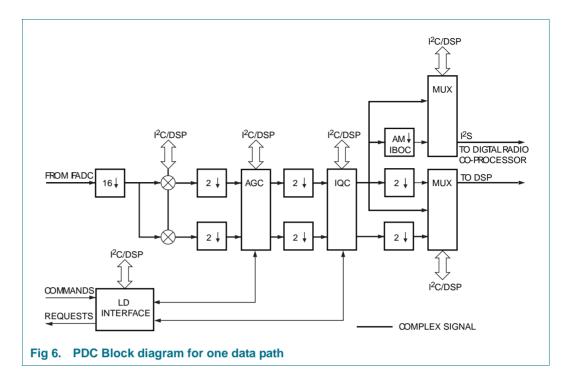
The input sample rate of 41.6 MSa/s is decimated by 16 MSa/s to 2.6 MSa/s.

7.1.2.3 Shift-to-baseband mixer

For the wanted signal, the TEF7000 tuner has an IF frequency of 300 kHz for FM and 60 kHz for AM: for the image signal these values are -300 kHz and -60 kHz respectively. The shift-to-baseband mixer shifts the wanted signal by $-f_{mix}$ to baseband and the image signal by $+f_{mix}$. The mixer has two independent registers for the wanted frequency alignment:

- fmix_0 with high-side injection
- fmix_1 with low-side injection

In TEF6730 mode fmix_0 and fmix_1 are 300 kHz for both FM and AM

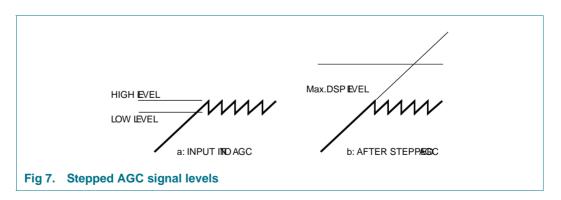


7.1.2.4 Mixer output decimation

The output signal of the shift-to-baseband mixer is decimated by two to 1.3 MSa/s before it enters the AGC stage.

7.1.2.5 Gain control

Both the wanted and the image signals are gain-controlled in the AGC stage. This contains a stepped gain stage, a linear gain stage and IF signal level detection. The linear gain stage ensures that maximum use is made of the dynamic range (see Figure 7).



Various gain-step compensation controls are implemented to reduce the audible effects of the gain steps. To increase the dynamic range of the tuner, gain-step compensation takes place in the AGC block of the PDC for:

- Step-response amplitude
- Step-response waveform
- Step-response timing

7.1.2.6 Stepped gain amplitude

The tuner communicates a new gain setting to the SAF7741HV via the DL interface. The SAF7741HV has four independent and different stepped AGC banks:

- AGC A
- AGC B
- AGC C
- AGC D

The number of steps for each AGC bank and the associated resolution is listed in Table 4.

| Table 4. | Stepped AGC gain reduct | tion | | |
|----------|-------------------------|-----------------|----------------|------------|
| AGC | Function | Number of Steps | Number of Bits | Resolution |
| AGC_A | LNA_1 | 16 | 12 | 50 mdB |
| AGC_B | LNA_2 | 8 | 11 | 50 mdB |
| AGC_C | Mixer | 4 | 10 | 50 mdB |
| AGC_D | IF | 4 | 10 | 50 mdB |

The AGC tables contain the corresponding gain reduction values of the tuner, expressed in bits. Zero gain reduction is at the top of each table. The tuner has random access to the table. The maximum single amplitude change of the AGC is 16 bits -1 LSB. This is equivalent to 96 dB. This maximum amplitude change can be made in any combination of AGC values from AGC_A up to AGC_D. The last gain reduction command from the tuner

is readable by the DSP in the AGC Change registers. Found in AGC Data Out registers are:

- The total stepped gain reduction
- The linear gain reduction
- The resulting gain reduction

The TEF7000 tuner uses:

- AGC_A and AGC_B for wideband AGC (in this case LNA_1 and LNA_2)
- AGC C for the mixer AGC
- AGC D is used as IF AGC

Remark: The AGC_A, AGC_B and AGC_D replace the pin-diode AGC in the TEF6730.

Step-response waveform 7.1.2.7

The compensating step-response waveform depends on the step response type to be compensated. Compensating waveforms for the LNA and the mixer gain steps are stored in ROM for both the IF response and the wideband response. The IF response is derived from the PDC response before the AGC stage.

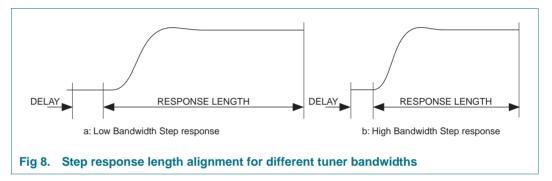
The step-response waveform from the ROM is used when the gain change is less than 12 dB. This results in compensation which is not audible and which therefore does not require muting.

When there is a gain change of more than 12 dB this is made step-wise without running the compensation waveform. This is the case with either Alternate Frequency (AF) updates or a pre-set change. These functions are always used in a muted condition and are therefore not audible.

7.1.2.8 Step-response timing

In order to align for the bandwidth of the analog circuits, an alignment is made between the response length and the response delay. This alignment is separate for the wideband and the IF responses.

Both the delay and the response length for the IF response are dominated by the PDC response before the AGC. These values are independent of the tuner response. The wideband response is different for analog and for digital AM/FM.



7.1.2.9 Perfect step compensation

Perfect step compensation of the tuner gain steps is made possible for signals within the IF signal band by alignments of amplitude, waveform and waveform delay. Near-perfect alignment is possible for off-centre signals within the IF signal band.

7.1.2.10 Non-perfect step compensation

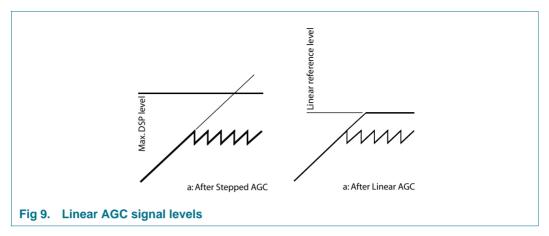
Perfect compensation of the tuner gain steps is not possible for signals outside the IF signal band. In such cases the resulting interference must be suppressed. In the PDC, four signalling bits are provided for this purpose:

- AGC_A_CHANGE
- AGC_B_CHANGE
- AGC_C_CHANGE
- AGC_D_CHANGE

These bits can be read by the DSP and a soft-mute signal can be generated when required.

7.1.2.11 AGC linear gain

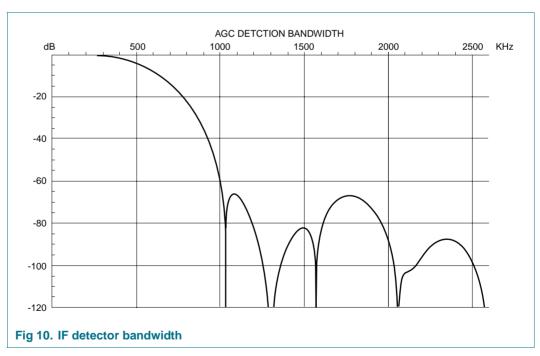
Data-path signals that exceed a certain level are kept constant in a linear controlled-gain stage (see Figure 9). Linear control avoids overload of the following signal stages and makes sure that maximum use is made of the data path's dynamic range. The I²C interface sets the reference level for linear control as well as the corresponding attack and delay values.



The linear control reference level should be above the maximum uncontrolled input level of the linear control stage (See Figure 7). Settings of the reference level below the maximum uncontrolled input level will result in a distorted output signal.

7.1.2.12 IF signal level detection

Signal level detection for wideband AGC is handled in the tuner. The resulting AGC steps are then interfaced to SAF7741HV and a step compensation is made. The IF AGC is controlled by level detectors within the PDC, and by IF detector high- and low-level settings which can be set via IC. The level detectors in the PDC communicate with the tuner to increase or decrease the level of the incoming signal.



The IF detector bandwidth is shown in Figure 10.

7.1.2.13 AGC output decimation

The output signal of the AGC is decimated by two to 650 kSa/s before it enters the IQC stage.

7.1.2.14 IQC stage

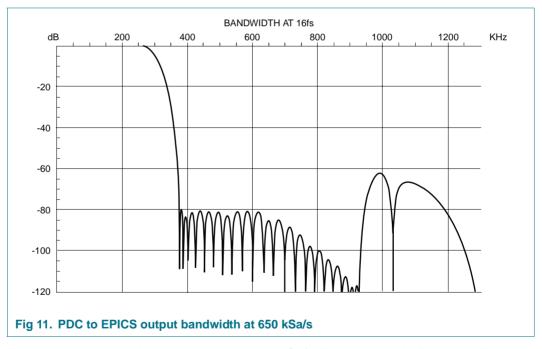
The IQC stage suppresses the image mirror co-channel within the wanted signal and corrects for gain and phase imperfections in the analog mixer and the subsequent analog data base. This is done by measuring and correcting possible correlations between the wanted and the image signals.

The IQC is an adaptive algorithm based on a Normalized Least Mean Square (NLMS). Normalization is performed off the data path in the Least Mean Square (LMS) adaptation engine itself, and therefore does not affect the output signals of the PDC. It takes place in steps of 6.0 dB with an associated averaging filter. Four coefficients are available to allow the IQC to manage frequency dependencies introduced by the analog IF filters. The adaptation rate parameter (mu) is controlled automatically at startup to make sure that the coefficients converge correctly.

An adaptation freeze level can be set to prevent tap drift in weak signal conditions.n TEF6730 mode the IQC stage is bypassed.

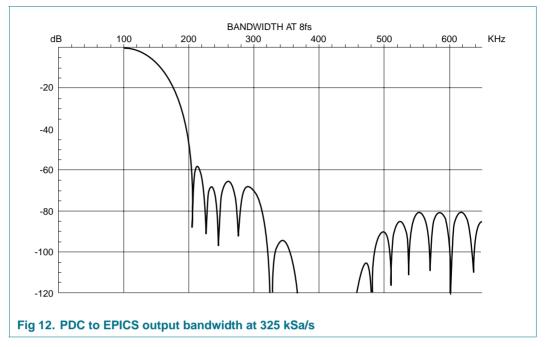
7.1.2.15 PDC output

The PDC has two outputs; one to the software radio and the other to the external pins. For the output to the software radio a choice can be made between three signals. The first of these is the wanted signal at 650 kSa/s. The bandwidth for this is shown in .<u>Figure 11</u>

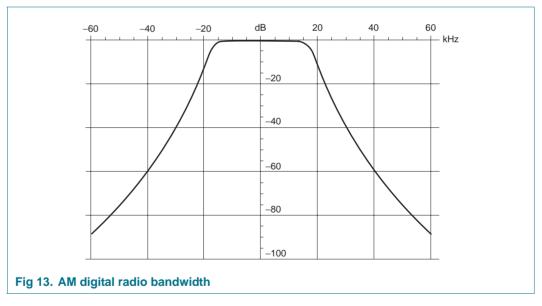


The second choice is the wanted signal at 325 kSa/s. This is shown in <u>Figure 11</u>. The third choice is the wanted/image signal pair at 325 kSa/s. The signal bandwidth for this is shown in <u>Figure 12</u>.

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For the I²S external output a choice can be made between FM and AM digital radio, both at 650 kSa/s and both wanted-signal only. All PDC input and output signals are complex.



7.1.2.16 LD interface

The SAF7741HV is designed for a generic tuner with TEF7000 architecture. Communication between the tuner and the SAF7741HV uses the proprietary two-line LD interface for AGC, injection-mode and bandwidth settings.

The tuner sends commands to the SAF7741HV while the SAF7741HV sends requests to the tuner. A tuner command is always executed unconditionally by the SAF7741HV, but a request from the SAF7741HV to the TEF7000 may be ignored.

AGC commands define the gain compensation required to compensate for the gain change of the tuner, and can also reset detectors in the stepped and the linear AGC.

The LD interface commands and their bit allocation are listed in <u>Table 5</u>. Refer to the tuner data sheet for the different signal bands.

| Table 5. | LD interface command bit allo | ocation | |
|----------|-------------------------------|---------|-----------|
| Bit | Function | Bit | Function |
| B22 | Reserved | B10 | AGC_C[1] |
| B21 | Reserved | B09 | AGC_C[0] |
| B20 | Reserved | B08 | AGC_D[1] |
| B19 | Reserved | B07 | AGC_D[0] |
| B18 | Reserved | B06 | AGC_DM |
| B17 | AGC_A[3] | B05 | RST_DET_D |
| B16 | AGC_A[2] | B04 | RST_LIN |
| B15 | AGC_A[1] | B03 | INJ |
| B14 | AGC_A[0] | B02 | INJM |
| B13 | AGC_B[2] | B01 | BW |
| B12 | AGC_B[1] | B00 | BWM |
| B11 | AGC_B[0] | _ | _ |
| | | | |

The LD interface requests from the SAF7741HV and their bit allocations are listed in Table 6.

| Table 6. | LD interface request bit allocation | |
|----------|-------------------------------------|--|
|----------|-------------------------------------|--|

| Bit | Function |
|-----|----------|
| B06 | Reserved |
| B05 | Reserved |
| B04 | Reserved |
| B03 | DET_D[1] |
| B02 | DET_D[0] |
| B01 | INJ |
| B00 | BW |

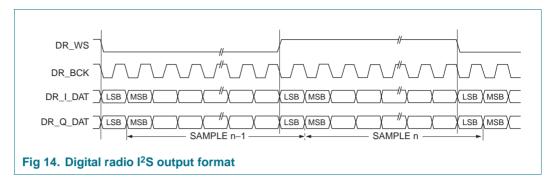
In TEF6730 mode, the DL Interface is replaced by 2 IF-AGC bits.

7.1.3 Digital radio interface

For digital radio an I²S output is provided for the I and Q signals (see <u>Figure 14</u>). A GPIO pin can be used as a blend input that makes it possible to switch from conventional FM and AM processing to digital radio processing.

There are two possible ways to get digital radio data:

- Digital radio interface 1 output, from either PDC1 or PDC2
- Digital radio interface 2 output via the T1E I²S interface from PDC2



7.1.4 RGP DAC

RGP digital-to-analog conversion is performed by a 10-bit DAC with a buffered output. This is part of the radio subsystem and can be used for various functions linked to the radio domain.

A double buffered interface is located between the DSP and the RGP DAC. The buffer is 2×8 words in length, which means that data with a maximum sample rate of 8 Fs (i.e. 325 kHz) can be transferred to the output when the DSP is running at 1 Fs (i.e. 40.625 kHz).

7.1.4.1 TEF6730 tuner compatibility

In TEF6730 tuner compatibility mode the general-purpose DAC can be used for controlling the PIN diode in front of the tuner. In addition to its digital AGC function this operates as second-level gain correction for the IFADC.

7.1.5 Radio Data System demodulator/decoder

7.1.5.1 General description

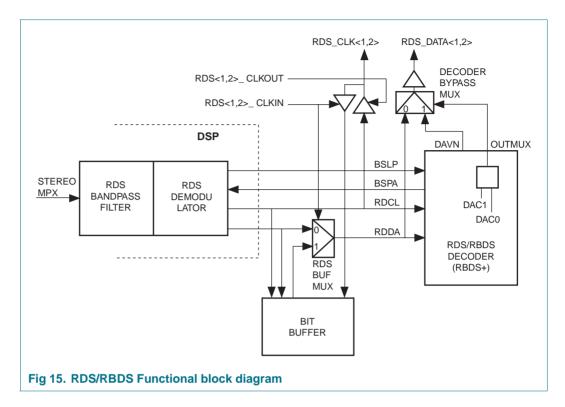
There are two Radio Data System (RDS) demodulation and decoder systems available on the SAF7741HV. The description below applies to each of them.

The RDS function recovers the additional and inaudible RDS information transmitted by FM radio broadcasting. The operational functions of the demodulator and the decoder are in accordance with EBU specification EN50067.

The function processes the RDS signal frequency-multiplexed within the stereo MultiPleX (MPX) signal to recover the information transmitted over the RDS data channel. This processing consists of band-pass filtering, demodulation and RDS/ Radio Broadcast Data System (RBDS) decoding. The RDS band-pass filter discards the audio content from the input signal and reduces the bandwidth.

The RDS demodulator regenerates the raw RDS bitstream (bit rate = 1187.5 Hz) from the modulated RDS signal. Connection to the RDS/RBDS decoder is by means of the DSP flags (see Figure 15).

Under I²C control via bit rds_clkin an internal buffer can be used to read out the raw RDS stream in bursts of 16 bits. With the I²C bit rds_clkout the RDS clock can be either enabled or switched off.



The RDS/RBDS decoder provides:

- Block synchronization
- Error detection
- Error correction
- Complex flywheel function
- Programmable block data output

Newly processed RDS/RBDS block information is signaled to the main microcontroller as 'new data available' by use of the DAVN output. The block data itself and the corresponding status information can be read out by means of an I²C bus request.

The RDS chain derives data information from the MPX signal independently of either the analog or the digital audio streams. This allows RDS updates during playback from tape or other sources.

7.1.5.2 RDS I/O modes

Apart from the control inputs and data outputs via the I²C inteface, the inputs and the outputs related to the RDS function are listed in <u>Table 7</u>, <u>Table 8</u> and <u>Table 9</u>

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| Name | Description |
|----------|---|
| RDS_CLK | Clock of the raw RDS bit stream. This is extracted from the bi-phase coded baseband signal by the RDS demodulator. The clock period is 1.1875 kHz. See Ref. 1 for more details. |
| RDS_DATA | Raw RDS bit stream, generated by the demodulator. This allows for external receivers of the RDS data to clock the data on the RDS_CLK signal as well as o its inverse. See Ref. 1 for more details. |
| | |
| | Iffered raw RDS output mode (rds<1,2>_clkin = 1, rds<1,2>_clkout = 0 and AVD mode: dac0 = 1, dac1 = 1) Description |
| DA | uffered raw RDS output mode (rds<1,2>_clkin = 1, rds<1,2>_clkout = 0 and AVD mode: dac0 = 1, dac1 = 1) |

Table 9. DAVA, DAVB and DAVC modes (rds<1.2> clkin = 0, rds<1.2> clkout = 0) Name Description

| davn | Data-available signal for synchronization of a data request between the main |
|------|--|
| | controller and the decoder (for further information see <u>Ref. 2</u>). |

Remark: Rds<1.2> clkin = 1 and rds<1.2> clkout = 1 is NOT an allowed mode.

Depending on the mode selected, the same output is used for RDS DATA and DAVN (see Figure 15).

7.1.5.3 RDS timing of clock and data signals in DAVD mode

The timing of the clock and data outputs is derived from the incoming data signal. Under stable conditions the data will remain valid for 400 ms after the clock transition. The timing of the data change is 100 ms before a positive clock change. This timing is well suited to positive- and negative-triggered interrupts on a microprocessor.

It is possible that phase faults will occur during poor reception, in which case the duty cycle of the clock and data signals will vary between a minimum of 0.5 and a maximum of 1.5 times the standard clock period. Faults in phase do not normally occur on a cyclical basis. See also Section 14.1.

7.1.5.4 RDS bit buffer

The repetition frequency of the RDS data is 1187.5 Hz. This results in an interrupt on the microprocessor every 842 ms, but the double 16-bit buffer allows this timing requirement to be relaxed since the two 16-bit buffers are filled alternately. If a buffer has not been read out by the time the other buffer is filled it will be overwritten and the old data will be lost. While a 16-bit buffer is being filled the RDS bit buffer keeps the data line high.

When a 16-bit buffer is full the data line is pulled down. The microprocessor has to monitor the data line at least every 13.5 ms. The data line remains low until the microprocessor pulls the clock line low. This starts reading out of the buffer, and the first bit is put on the data line. The RDS bit buffer puts a bit on the data line after every falling clock edge, and

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the data remains valid while the clock is high. After 16 falling and 16 rising edges the whole buffer is read out and the bits are stored by the microprocessor. After a 17th falling clock edge the data line is set high until the other 16-bit buffer is full. The microprocessor stops communication by pulling the clock line high again. See <u>Section 14.1</u>.

7.1.5.5 RDS demodulator

The RDS demodulator is implemented in DSP software. See <u>Ref. 1</u> for details of its functionality.

Demodulator decoder interface: Communication between the RDS demodulator and decoder is provided by Economic Parameterized Integrated Cores (EPICS) flags and consists of four signals as shown in Figure 15.

Remark: Instead of the EPICS flags, the RDS decoder connection register can be used for demodulator decoder communication. For further details see Ref. 3.

Table 10. Signals provided by the demodulator

| Name | Description |
|------|--|
| rdcl | Demodulator clock output. Generated by the RDS/RBDS demodulator for every RDS/RBDS clock period (1.1875 kHz). This pulse remains high for about half of an RDS/RBDS clock period (~420 μ s). The rising edge of this signal is used as an input shift enable for the decoder internal data buffer (RDS Data Output [RDDA] bit input). It is assumed that the RDDA input will remain unchanged for at least one system clock (10.4 MHz) after a rising RDCL edge. |
| rdda | Demodulator data output. Represents the actual RDS/RBDS data bit. The RDDA is shifted into the decoder module internal data buffer by detection of a rising edge on the RDCL input signal. |
| bslp | Bit-Slip (BSLP) detected. This is set to high for at least one RDS/RBDS clock period (1.1875 kHz), but only when the demodulator detects a possible BSLP. The BSLP signal itself has to be reset to low after one RDS/RBDS clock period. |

Table 11. Signals received by the demodulator

| Name | Description |
|------|--|
| bspa | Bit-Slip Process Active (BSPA). This is set to HIGH when the RDS decoder detects a BSLP: at all other times it is LOW. |

Remark: The current version of the SAF7741HV firmware does not use bslp/bspa signalling. This is implemented in the hardware, and is therefore mentioned here for information only.

7.1.6 8Fs I²S interface

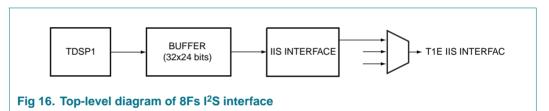
The 8Fs I²S interface is used to transform the parallel data outputs of the TDSP1 (24 bits wide) to serial data in I²S format, and then make that data available at the digital radio interface 1 (see Figure 16). The TDSP1 has the capability to write data to the interface at 1Fs, 2Fs, 4Fs and 8Fs.

Depending on the flag values, the interface can send data in I²S format at 1Fs, 2Fs, 4Fs, 8Fs and 16Fs.

Table 12 gives all possible combinations of speeds at which the interface receives and sends data.

| | the second se |
|-------------|---|
| TDSP1 Speed | I ² S Speed |
| 1Fs | 1Fs, 2Fs, 4Fs, 8Fs |
| 2Fs | 1Fs,2Fs, 4Fs, 8Fs, 16Fs |
| 4Fs | 1Fs,2Fs,4Fs, 8Fs,16Fs |
| 8Fs | 1Fs,2Fs,4Fs,8Fs, 16Fs |

The size of the buffer is determined by the largest factor between the speeds of the TDSP1 and the IIS, which is the case when the TDSP1 runs at either 1Fs and the IIS at 8Fs or when the TDSP1 runs at 2Fs and the IIS at 16Fs. In the first case the TDSP1 has to be able to write two words of 24 bits - i.e. left data and right data for stereo samples at 1Fs speed - and the speed at which the read should be performed by the IIS interface is 8Fs. Therefore the required buffer size is 16×24 bits. Moreover, the buffer is required to support double buffering; i.e. it can be written to and read from at the same time. This makes the total size of the buffer 32×24 bits.



7.1.7 Tuner I²S interface

The Tuner I²S interface provides a connection between the output multiplexer and TDSP1E. There are two data converters, one converting parallel data (24 bits wide) to IIS format and the second converting from I²S format to parallel. The two converters both run at the TDSP1E sample rate. The format of the I²S data can be configured by setting the applicable registers, and the internal I²S generator and I²S receiver both work as masters. The result is that the signals 'word select' and 'serial clock' are always generated internally.

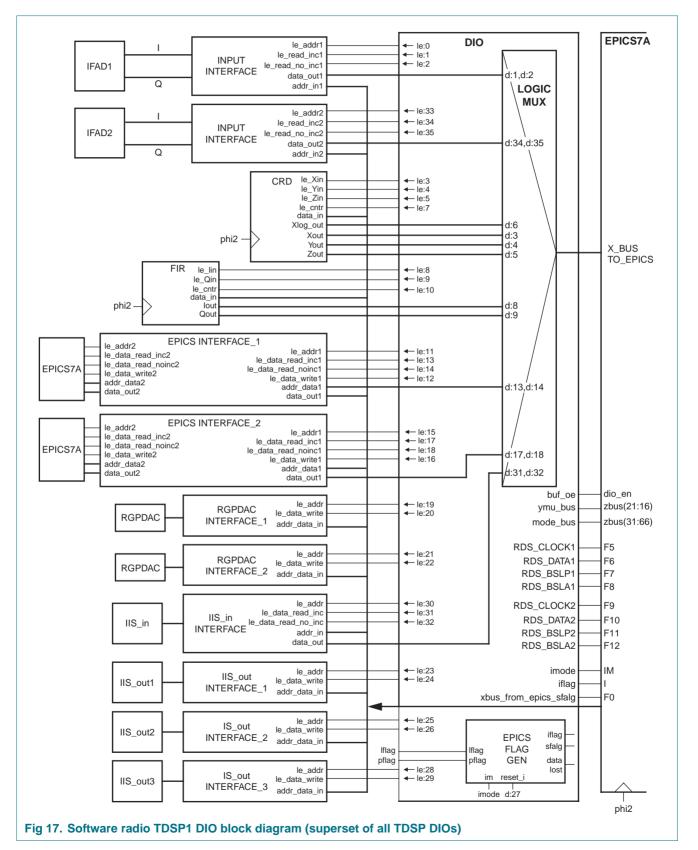
7.1.8 Output multiplexer

The output multiplexer behind the tuner I^2S interface maps four different serial data streams to and from the pins:

- Data going to or coming from the tuner I²S interface (I²S in/out)
- Data T1 coming from the software radio and going to the SRC DSP (SDSP) (I²S out)
- Data T2 coming from the software radio and going to the SDSP (I²S out)
- Data coming from PDC2 (digital radio format out)

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The user flags of the TDSPs can be programmed for various functions described below. Every TDSP has 13 I/O flags available. <u>Table 13</u> shows all the possibilities for each user flag.

| Table 13. | TDSP user flags | | | |
|-----------|-----------------|--|---------------------|---------|
| User Flag | Chip Pin Name | Function | Mode ^[1] | |
| | | | I/O | Stretch |
| F0 | _ | SFLAG input from EPICS flag generator | IN | OFF |
| F1 | TDSP_IOF1 | User-defined in or out | IN/OUT | ON/OFF |
| F2 | TDSP_IOF2 | User-defined in or out | IN/OUT | ON/OFF |
| F3 | TDSP_IOF3 | User-defined in or out | IN/OUT | ON/OFF |
| F4 | TDSP_IOF4 | User-defined in or out | IN/OUT | ON/OFF |
| F5 | TDSP_IOF5 | User-defined in or out/clock output to RDS decoder1 | IN/OUT | ON/OFF |
| F6 | TDSP_IOF6 | User-defined in or out/data output to RDS decoder1 | IN/OUT | ON/OFF |
| F7 | TDSP_IOF7 | User-defined in or out/BSLP output to RDS decoder1 | IN/OUT | ON/OFF |
| F8 | TDSP_IOF8 | User-defined in or out/bspa input from RDS decoder1 | IN/OUT | ON/OFF |
| F9 | TDSP_IOF9 | User-defined in or out/clock output to RDS decoder2 | IN/OUT | ON/OFF |
| F10 | TDSP_IOF10 | User-defined in or out/data output to RDS decoder2 | IN/OUT | ON/OFF |
| F11 | _ | ADSP TDSP1E interface/RDS decoder | IN | ON/OFF |
| F12 | _ | Out flag to the WDOG value registers/ADSP TDSP1E interface/RDS decoder | IN | ON/OFF |

[1] All I²C-controllable

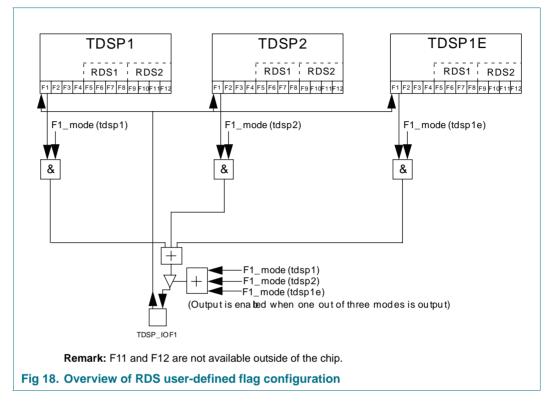
There are 10 general purpose I/O pins available for the software radio. These have to be shared between the available TDSPs as shown in <u>Figure 18</u>. In this diagram only TDSP_IOF1 is depicted since all the other flags are connected the same way.

In the description that follows the value of 'n' can be 1 to 10.

- 1. Pin TDSP_IOFn is wired directly to the input flag 'n' of each TDSP.
- 2. The output flags 'n' of all the TDSPs are OR-ed together and the resulting signal is wired to TDSP_IOFn.
- 3. All the flags on all the separate TDSPs can be set to input or output in the I²C registers. The pad of TDSP_IOFn is input when all TDSP flags 'n' are set to input: otherwise it is used as an output.
- 4. All the flags on all separate TDSPs can be set to stretch mode or non-stretch mode in the I²C registers.

There are exceptions to the above description. On the chip there are two RDS decoders that can be connected to either of the TDSPs, using predefined pins on the DSP when connected. The corresponding TDSP pins connected to the RDS decoder are then fixed as RDS pins and are no longer available as user-defined. The stretch mode of the

corresponding pins is switched off. Which RDS decoder is connected to which TDSP is controlled in the l²C registers. <u>Table 13</u> shows which flags are used for RDS when connected.



7.1.9.1 EPICS flag generator

The EPICS flag generator generates two flags: IFLAG and the Sync Flag (SFLAG). IFLAG is connected to the 'I' input flag of the EPICS and SFLAG is connected to the user flag 0. SFLAG indicates that the EPICS should use page0 of the EPICS interface memories to avoid read and/or write errors and conflicts.

The normal duration of IFLAG is four EPICS clock periods. The SFLAG is set until the next IFLAG is generated.

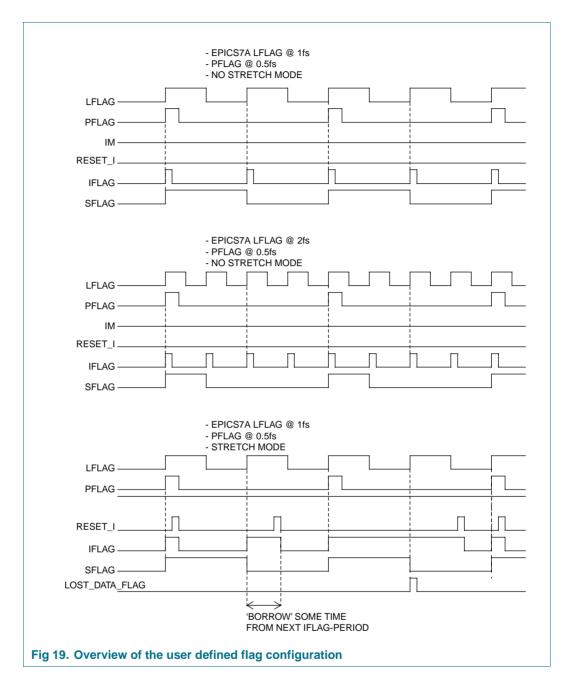
The EPICS can stretch (IMODE) IFLAG via the IM input.

7.1.9.2 Flag overview

When IFLAG is in stretch mode (IM is high) the flag is set at every rising edge of LFLAG. IFLAG can be reset only with the RESET_I input connected to a DIO address. When this address is read by the EPICS, RESET_I is pulsed. SFLAG is not stretched. If IFLAG is not cleared before the next LFLAG the LOST_DATA flag is set.

When IFLAG is not in stretch mode (IM is low) then an IFLAG is generated at every rising edge of the LFLAG. If at this point PFLAG is high, then SFLAG is set until the next rising edge of LFLAG (see Figure 19). LFLAG and PFLAG are generated in the software radio flag generator.

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7.2 Audio subsystem

The audio subsystem (see Figure 2) consists mainly of four sequential sections:

- Input section (analog and digital)
- SRC section
- Audio processing section
- Audio output section

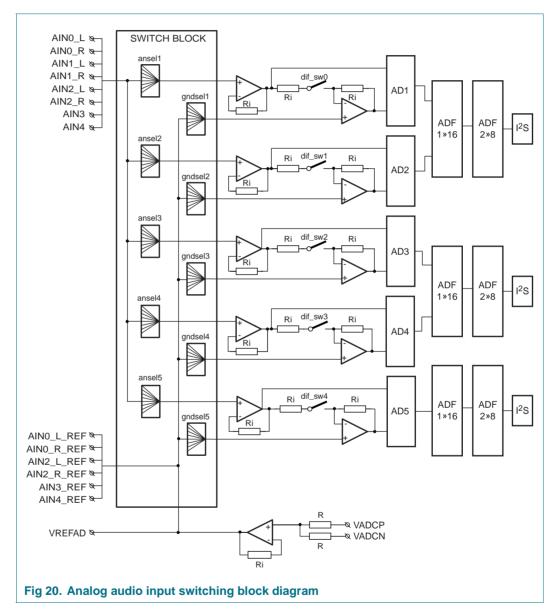
7.2.1 Input section

The audio input section is split into an analog and a digital input.

7.2.1.1 Analog audio input paths

The analog input section consists of an analog source selector and five ADCs. The outputs of the ADCs are connected to the ADSP. The audio sample rate of these inputs can be a maximum of 55 kHz. When the ADSP runs at a higher rate the inputs need to be routed via a software up-sampler.

7.2.2 Signal flow of the analog audio input



The input switching for the five possible analog channel setups is very flexible. Using the switches gndsel0 to gndsel4 (see) and ansel0 to ansel4 all combinations can be made either for normal inputs or for high common-mode inputs with a ground connection (see Figure 20)

In principle, any signal input can be connected to any ADC. However, it is possible to make the stereo signals use the even-numbered ADCs (ADC0, ADC 2 and ADC4) for the left channels and the odd-numbered ones (ADC 1 and ADC 3) for the right channels. The only conditions are that:

- When the input signals do not have a ground pin the minus input of the second Op-amp in the signal chain must be connected by means of the gndsel switches to the VREFAD line.
- When there is a high common-mode input with ground input pin the associated gndsel switch must be connected to this pin.
- Some connections to the switching matrix are 'reserved'. These must not be used.

Selection of analog signal switches Table 14. Position **ANSEL1 to ANSEL5** 000 AIN0_L 001 AIN0 R 010 AIN2 L 011 AIN2_R 100 AIN3 101 AIN4 110 AIN1_L 111 AIN1_R

Table 14 and Table 15 show the possible connections.

Table 15. Selection of the analog ground switches

| | delection of the analog ground switches | |
|----------|---|--|
| Position | ANSEL1 to ANSEL5 | |
| 000 | AIN0_L_REF | |
| 001 | AIN0_R_REF | |
| 010 | AIN2_L_REF | |
| 011 | AIN2_R_REF | |
| 100 | AIN3_REF | |
| 101 | AIN4_REF | |
| 110 | VREFAD | |
| 111 | Reserved | |
| | | |

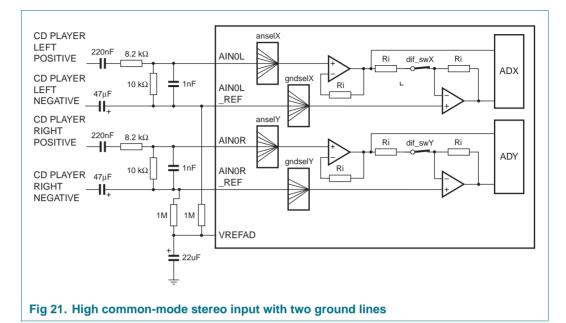
7.2.3 Realization of the common mode inputs

A high Common-Mode Rejection Ratio (CMRR) can be created for all the analog inputs by use of the ground pins. To create a signal input, connect the ground pin that is to be used to the second Op-amp in the signal path by using the gndsel switch. This ensures that the two signal lines that go to the ADC will contain the common-mode signal. The ADC itself will suppress the signal very effectively, so in this way good common-mode signal suppression will be achieved.

An example of a high common-mode stereo input with two ground shielding lines is shown in Figure 21.

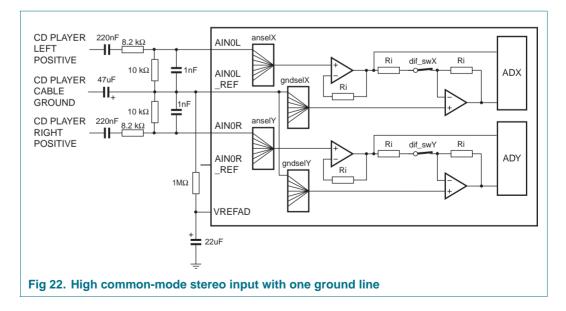
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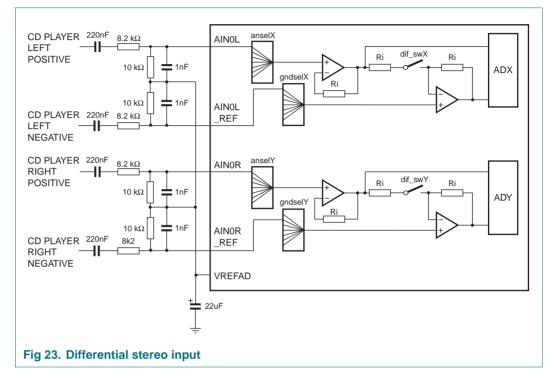


In this example input voltage reduction is accomplished by the external 8.2 k Ω to 10 k Ω resistor divider. The rather low-value resistor divider is necessary because in this case the parasitic capacitance on pins AINO_L and AINO_R will reduce the common-mode signal on them. The CMRR can be guaranteed when the source and cable impedance do not exceed the specified value as stated in the conditions column of <u>Table 35</u>. This leads to a reduction of the CMRR when the source impedance is too high. Half of the supply voltage is provided as reference by connecting the negative inputs of the second operational amplifier to VREFAD by means of the gnd_sel switches and the external 1.0 M Ω resistor. The 1.0 nF capacitors are used for anti-aliasing.

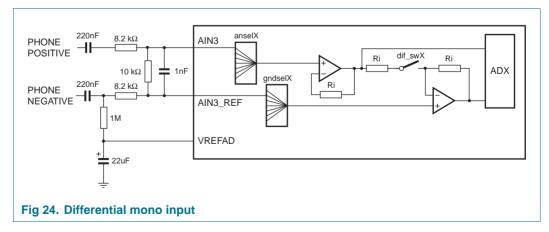
An example of a high common-mode input with only one ground-shielding line is shown in Figure 22.



A full-stereo differential input of a CD changer is shown in Figure 23. The switches dif_sw are shown open, and only when signals on the inputs (marked POS and NEG) are different will analog-to-digital conversion take place. Common-mode signals on the inputs will also appear as common-mode signals on the ADC inputs and will not be converted to the digital data stream.

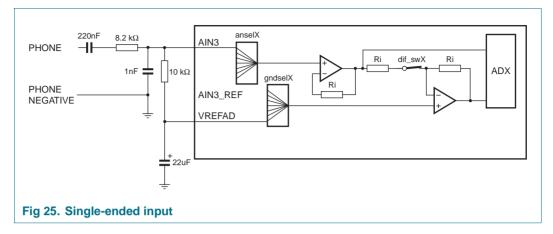


The differential-mode application of a single-ended input is shown in Figure 24. In this case the input voltage is reduced symmetrically with two 82 k Ω resistors and one100 k Ω resistor. This neutralizes the effect of parasitic capacitance on the AIN3 input and the AIN3_GND input to permit a relative high-ohmic resistor divider to be used. In this example common-mode signals which have not been reduced in value are applied to the ADC. The ADC itself has a very good CMRR, so this input also has a high CMRR.



In <u>Figure 25</u> a single-ended input is shown. The reference here is VREFAD which is connected internally, so no common-mode rejection can be expected.

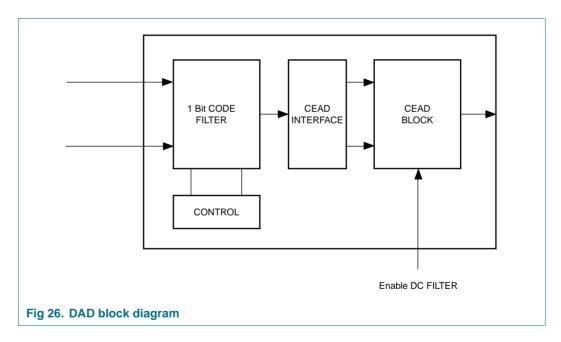
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7.2.4 Audio ADC decimator paths (DAD)

7.2.4.1 Functional description

Decimation of the audio ADC signals is completed in a block called DAD. This block can handle the signals from two ADCs, so a stereo signal can be processed.



The input signal has a sample frequency of $128 \times fs$ and comes from a third-order $\Sigma \Delta$ ADC. The first step in the decimation process is done by the 1-bit code Cascaded Integrator Comb (CIC) filter and Audio Decimation Filter 1 (ADF1) filter. See Figure 26. The CIC filter decimates the input sample rate by a factor of 16 and thus results in a sample rate of $8 \times fs$.

After the 1-bit code filter, sample reworking is necessary to enter the CEAD block and the ADF2. The CEAD block further decimates the audio samples by 8, giving a sample rate of $1 \times fs$. The overall gain in the pass band of the decimation filter (including the CIC filter and the CEAD block) becomes 4.85 dB. A nominal input level of -8.45 dB comes from the ADC and results in a -3.6 dB level after decimation.

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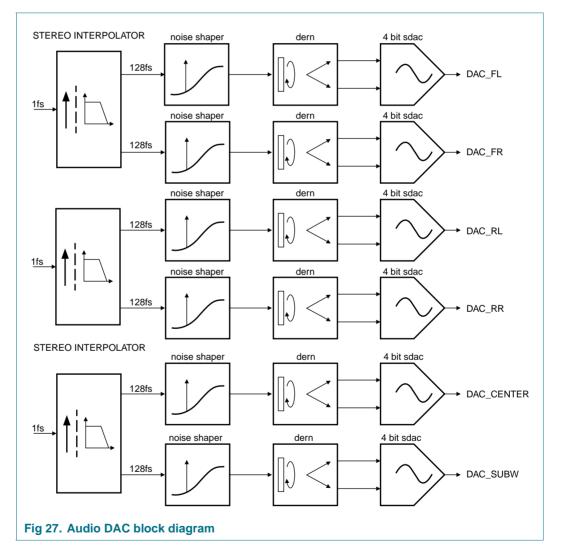
The DC filter in the CEAD block is controlled by an I^2C bit that can be found in <u>Ref. 3</u>. Power-on reset circuitry is not implemented, which means that after power-up all filters will go through a brief transient phase before they reach their steady-state behavior.

7.3 Audio Digital-to-Analog (ADAC) conversion

The ADAC module consists of a DAC, an interpolation filter and a noise shaper for the audio. Both the analog and the digital functions are described here.

The digital part consists of an interpolation filter which increases the sample rate from 1 fs to 128 fs and a third-order noise shaper that runs at 128 fs.

The analog part consists of six single-ended DAC modules for the left, the right, the centre and the sub-woofer channels.



7.3.1 Functional description

The audio DAC comprises these functions:

• Digital up-sampling filter

- 3rd order noise shaper
- DAC including Compensations and the DEM algorithm

7.3.2 Digital filters

The interpolation from 1 fs to 128 fs is done in four stages:

- The first stage is a 99 tap Half-Band (HB) filter that increases the sample rate from 1 fs to 2 fs. It has a steep transition band to correct for the missing inherent filter function of the DAC used
- The second stage is a 31-tap FIR filter that increases the data rate from 2 fs to 8 fs. It compensates for the roll-off caused by the Sample and Hold (SH) function prior to the noise shaper
- The third stage is a simple hardware Linear Interpolator (LIN) function that increases the sample rate from 8 fs to 16 fs. It removes the 8 fs component in the output spectrum
- The fourth and last stage is a SH function increasing the sample rate from 16 fs to 128 fs.

The overall transfer characteristics can be found in Table 16.

| • | | |
|-----------------|-------------------|------------|
| Characteristics | Condition | Value (dB) |
| Passband ripple | 0 Fs to 0.4535 Fs | +0.02 |
| Stop band | >0.5465 Fs | -72 |
| Dynamic range | 0 Fs to 0.4535 Fs | >143 |

Table 16. Digital filter characteristics

7.3.3 Noise shaper

The 3rd-order noise shaper operates at 128 fs, shifting the in-band quantization noise to frequencies well above the audio band. This noise-shaping technique enables high signal-to-noise ratios to be achieved at low frequencies. The noise-shaper output is converted into an analog signal using a 4-bit Switched Resistor Digital-to-Analog Converter (SDAC).

7.3.4 DAC (4-bit SDAC)

The 4-bit DAC is based on a switched resistor architecture which forms a controlled voltage divider between the positive (VDACP) and the negative (VDACN) reference supplies. The 4-bit input data from the noise shaper is decoded first to a 13-level thermometer code to control the 15 taps of the converter. Data-Weighted Averaging (DWA) is added to the decoding to guarantee that there is no correlation between the input signal and the resistors used for that input signal.

After decoding and DWA the buffers connect the resistors to either the VDACP or the VDACN pin so that the reference voltage will be divided depending on the input signal. The result is an analog output voltage with a rail-to-rail maximum output swing. The output impedance of this DAC is approximately 1.0 k Ω . By applying an external capacitor of 3.3 nF to the output pin a 1st order low-pass post-filter is introduced with a -3.0 dB roll-off at 48 kHz (dimensioned for fs = 44.1 kHz). This will reduce the 3rd-order noise-shaped output spectrum of the DAC to a spectrum that increases with 2nd order.

Remark: The value of this capacitor depends on the actual sample frequency used.

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7.4 Digital audio I/O

Two groups of digital inputs to the audio subsystem can be distinguished:

- Inputs (I²S, SPDIF, I²S from radio subsystem) that run at their own sample frequency
- Inputs (HOST I²S) that run at a sample rate equal to that of the ADSP

At the output side only the HOST I²S outputs are available, also running at a sample rate equal to that of the ADSP.

There are provisions to enable I²S input 4 as a digital SPDIF input and to configure I²S input 1 and the SPDIF inputs as a six-channel DVD input, where the SPDIF inputs carry the serial data for the four additional channels.

There is provision to enable I^2S input 4 as a digital SPDIF input, and to configure I^2S input 1 and the SPDIF inputs as a six-channel DVD input where the SPDIF inputs carry the serial data for the four additional channels.

The I²S inputs (both primary and from the radio subsystem) and the SPDIF inputs are sample-rate converted by the SRC implemented on an EPICS7A core. The SDSP software supports three different modes:

- Stereo mode (maximum of five stereo SRCs)
- Multi-channel mode 1 (maximum of one six-channel SRC plus two stereo SRCs)
- Multi-channel mode 2 (one six-channel SRC)

The actual number of SRCs that can be active depends on the DSP clock frequency and the required sample rate. An additional stereo SRC is possible on the platform device in the ADSP and will depend on the code present in this DSP.

7.4.1 I²S inputs

An I²S digital interface bus can be used for communication with external digital sources. This is a serial three-line bus that has:

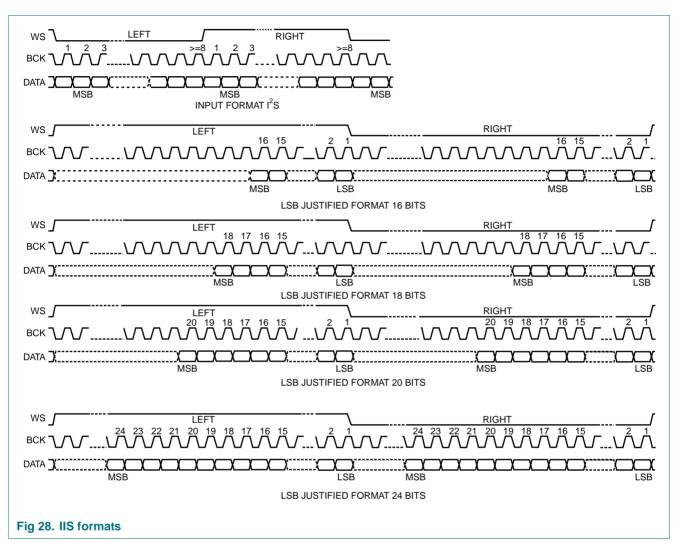
- One line for data
- One line for the clock
- One line for word-select

For external digital sources the SAF7741HV can act as a slave so the external source is master and supplies the clock.

Remark: The digital audio input is capable of handling multiple formats, so for simplicity the serial digital audio inputs and outputs are referred to as I²S. However, this does not mean that the format always conforms exactly to the published Philips I²S standard (see <u>Ref. 5</u>).

The I²S input is capable of handling Philips I²S- and LSB-justified formats of 16-bit, 18-bit, 20-bit and 24-bit word sizes. See Figure 28.

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See <u>Ref. 3</u> for the bits that must be programmed and for details of how to select the required I^2S format.

The number of BCK pulses may vary in the application. When the applied word length exceeds 24 bits the LSBs are not used. The input circuitry cannot handle an unlimited number of BCK pulses per WS period, so the maximum allowable number of BCKs per period is 256.

It is not necessary for the WS to have a 50% duty cycle in Philips I²S standard format. This means that the number of BCKs during high or low may be different. However this is not allowed for LSB-justified formats.

External IIS sources with a wide sample-rate range are supported: from 8 kHz up to 192 kHz. This does not mean, however, that any sample rate can be applied to the inputs and be handled simultaneously by the sample-rate conversion DSP. The audio bandwidth after sample-rate conversion is of course always limited to half of the master sample rate Fs.

7.4.1.1 General description of the SPDIF inputs

The design fulfils the requirements of the IEC60958 Digital Audio Interface specification (see <u>Ref. 6</u>) except for the input voltage, which is required to have a digital level. The interface is compliant with the electrical limitations of the pins (see <u>Table 23</u>).

There are two SPDIF independent input pins with their own SPDIF receivers. This means that two SPDIF signals can be processed in parallel.

The SPDIF receiver is not fitted with an analog PLL. The incoming SPDIF stream is sampled at a high frequency in the digital domain. From the SPDIF signal a 3-wire (I²S-like) serial bus is made consisting of word-select, data and bitclock lines. The Fs frequency depends solely on the accuracy of the SPDIF signal input.

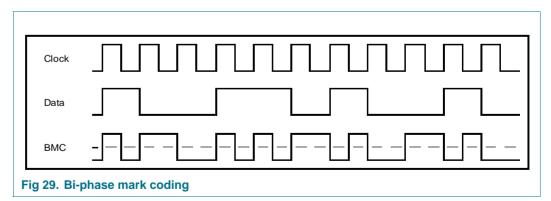
This design does not handle the user data bits of the SPDIF stream. The audio field of up to 24 bits is available at its output. The audio bits are always decoded regardless of any status bits; e.g. copy-protected, professional mode or data mode. However, a subset of the channel status bits is decoded and made available to the ADSP and the SDSP. In addition, the 'validity' bit is available. This means that the ADSP can prevent non-PCM audio or data being processed as audio. See the relevant tables in <u>Ref. 3</u> for the exact channel status bits supported. The supported bits are extracted from the left channel only.

SPDIF format: The SPDIF format was conceived to transport 2-channel PCM audio for distances of up to several hundred metres over a 3-wire balanced line. Alternatively the signal could be carried for shorter distances over a 2-wire pair.

The SPDIF format can be partitioned into two main layers:

- The abstract model of frames and blocks
- The channel modulation

SPDIF channel modulation: The digital signal is coded using Bi-phase Mark Coding (BMC), which is a type of phase modulation. In this scheme a logical 1 in the data corresponds to two zero crossings in the coded signal and a logical 0 to one zero crossing.



Since a logic 1 implies two transitions in the BMC signal, a clock at twice the bit rate assumes the use of all rising signal edges.

SPDIF sample rates: The IEC60958 specification allows the use of sample rates from 22.05 kHz to 192 kHz. The SAF7741HV is designed to support a very wide range of sample rates, but there are restrictions with respect to the processing power of the SDSP

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and the actual contained bandwidth of the audio information. Any product derivative with a fixed SDSP ROM code will have clear restrictions. The code for the SAF7741HV platform can be chosen for different implementations.

| Table 17. | Examples of the most | common SPDIE s | ample frequencies |
|-----------|----------------------|----------------|-------------------|
| | | | |

| Sample frequency (kHz) | Data rate (Mbits) | Channel rate (Mbits) |
|------------------------|-------------------|----------------------|
| 44.1 | 2.8224 | 5.6448 |
| 48.0 | 3.0720 | 6.1440 |
| 32.0 | 2.0480 | 4.0960 |

7.5 Host I²S I/O

A HOST I²S interface is available that features five inputs and four outputs. Configuration of the HOST I²S interface can be done via the I²C registers . Details can be found in Ref. 3.

7.6 ADSP

The ADSP processes audio features on five stereo audio channels coming from the SDSP, two stereo channels and one mono channel from the ADCs and eight stereo HOST inputs. In addition to this the ADSP can be used to sample-rate convert one additional stereo input to the same reference sample rate as all the other inputs. On the output side there are eight to 10 HOST outputs. The ADSP will control the switches in SwitchBox2 of the SDSP and SwitchBox1 in front of the ADC.

7.6.1 ADSP user flags

Eight user flags can be used to control several settings in the ADSP. The stretch mode as well as I/O direction of those flags is user-definable. Furthermore, there are two flags that are used as sample indicators for the SRC software and two flags that support an interface towards the TDSP1E in the radio subsystem (fixed input flags). Finally there is one flag that is connected to the WDOG status register. When this is used it must be configured as an output. The table below shows the function of each flag.

Table 18.ADSP user flags

| | | 5 | | |
|-----------|------|---|--------|---------------------|
| Pin name | Flag | Function | Мо | de <mark>[1]</mark> |
| | | | I/O | Stretch |
| _ | F0 | Internal divided sample rate flag (pflag) | IN | OFF |
| - | F1 | Internal source sample rate flag | IN | ON |
| - | F2 | ADSP TDSP1E interface | IN | OFF |
| - | F3 | ADSP TDSP1E interface | IN | OFF |
| ADSP_IOF4 | F4 | User-defined input or output | IN/OUT | ON/OFF |
| ADSP_IOF5 | F5 | User-defined input or output | IN/OUT | ON/OFF |
| ADSP_IOF6 | F6 | User-defined input or output | IN/OUT | ON/OFF |
| ADSP_IOF7 | F7 | User-defined input or output | IN/OUT | ON/OFF |
| ADSP_IOF8 | F8 | User-defined input or output | IN/OUT | ON/OFF |
| ADSP_IOF9 | F9 | User-defined input or output | IN/OUT | ON/OFF |

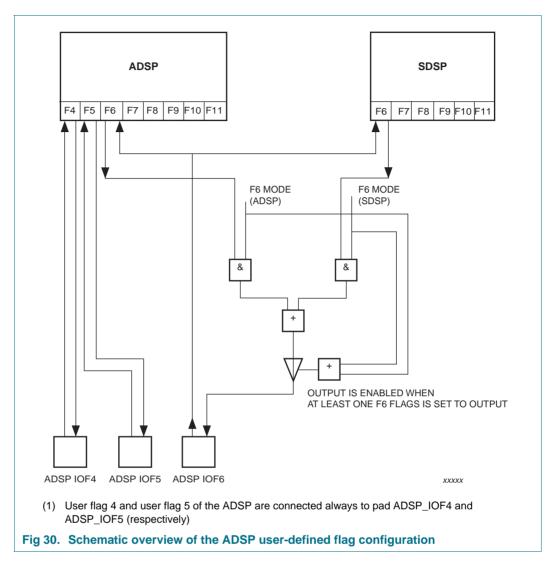
Table 18.ADSP user flags

| Pin name | Flag | Function | Mode [1] | |
|------------|------|---|----------|---------|
| | | | I/O | Stretch |
| ADSP_IOF10 | F10 | User-defined input or output | IN/OUT | ON/OFF |
| ADSP_IOF11 | F11 | User-defined input or output | IN/OUT | ON/OFF |
| _ | F12 | Output flag to the WDOG status register | IN/OUT | ON/OFF |

[1] All I²C controllable

In the description that follows, 'n' can be any value from 6 to11. See Figure 30 for details.

- The output flags 'n' of all the ADSPs or SDSPs are made to be OR-ed together, and the resulting signal is wired to ADSP_IOFn
- All flags on all the individual ADSPs and SDSPs can be set to either 'input' or 'output' in the I²C registers. The pad of ADSP_IOFn is an input when the two ADSP/SDSP flags 'n' are set to input: otherwise it is used as an output.
- All flags on the two separate ADSPs or SDSPs can be set to either stretch mode or non-stretch mode in the I²C registers
- User flags 4 and 5 of the ADSP are always connected to pads ADSP_IOF4 and ADSP_IOF5
- User flag ADSP_IOF11 is shared with the output wd_flag of the Watchdog (WDOG) module. This is configured by the IIC control register WD_CTRL (\$000090). Details can be found in <u>Ref. 3</u>.

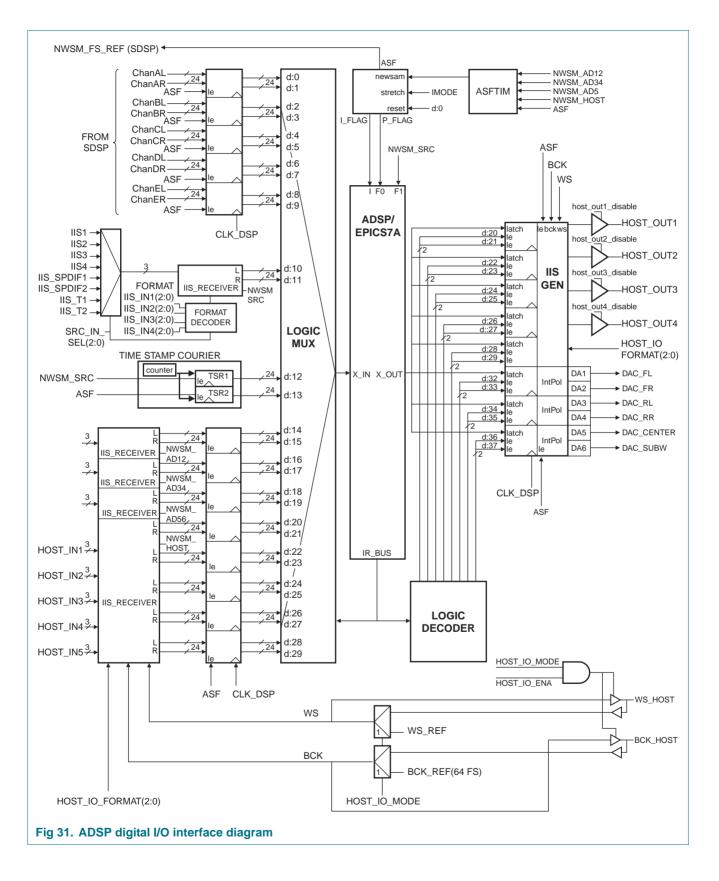


7.6.2 ADSP digital I/O inteface

The digital I/O interface (DIO) of the ADSP is realized via the XBUS. For the inputs a LOGIC_MUX is placed in front of the XBUS of the DSP. Mux selection is decoded from the instruction bus. For the SRC input, extra inputs are provided for the timestamp registers of the reference sample rate and the to-be-converted input. For the other inputs with the same sample rate but different arrival times, some extra buffering and scheduling of the sample valid pulse is calculated by an ASFTIM block. For each output a buffer is connected to the XBUS from the DSP and its latch-enable signal is decoded from the instruction bus as well. For an overview see Figure 31.

For further information on DIO mapping of the registers, see Ref. 4.

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The input format of HOST_IN, HOST_OUT and SRC INPUT can be selected via an I²C register. The source that will be sample-rate converted is also selected by I²C register bits (see <u>Ref. 3</u>). Control of these I²C bits will be maintained by the ADSP and the MicroProcessor Interface (MPI).

Extra DIO inputs are provided for registers that contain new sample time-stamps for the stereo input and one extra register for the reference sample rate. Combined with the new sample flags from the input and the reference flags, these time-stamps allow the DSP program to convert the sample rate to the reference on the output.

7.6.3 ADSP-TDSP1E interface

The ADSP TDSP1E communication interface provides two general-purpose communication channels between the ADSP and the TDSP1E, one for each direction. Each channel has two registers of 24 bits each:

- For the channel from the ADSP to the TDSP1E, the ADSP writes the data to the registers and the TDSP1E then reads this data
- For the channel from the TDSP1E to the ADSP, the TDSP1E writes the data to the registers and the ADSP then reads this data

A full handshake mechanism is provided In addition to the communication channel, but the communication channels can be used either with or without handshaking.

When the communication between the two DSPs requires a handshake, the software can test the input flags. The flags are either cleared or set by hardware under the condition of either reading from the second register or writing to the second register. See <u>Figure 32</u> for a block diagram of the communication interface.

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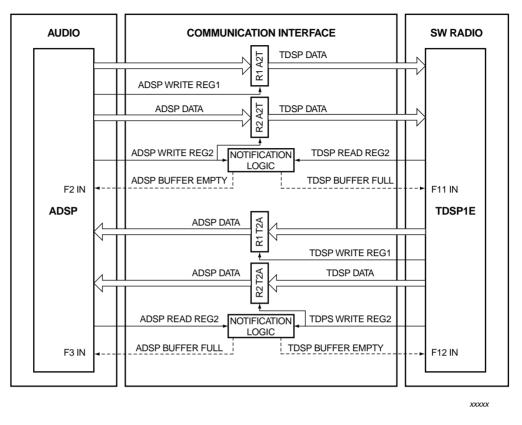
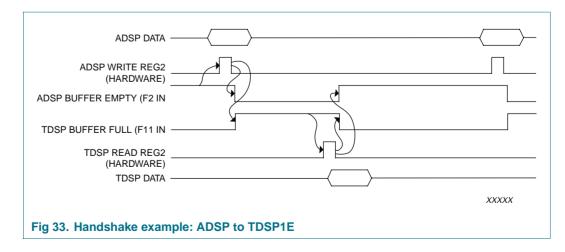


Fig 32. ADSP TDSP communication channel

7.6.3.1 Communication protocol example

Figure 33 is an example of the handshake protocol for one direction. The signal adsp_write_reg2 is equal to the ADSP DIO write signal for register R2_A2T (see <u>Ref. 4</u>). The signal 'tdsp_read_reg2' is equal to the TDSP1E DIO read signal for register R2_A2T. These two signals are used to generate the flags 'adsp_buffer_empty' and 'tdsp_buffer_full'.



7.6.3.2 Software interface description

The flag update is the result of either a 'write R2_A2T' or a 'write R2_T2A' instruction. For this reason checking these flags at the next instruction after writing to a communication interface register should be avoided because the flags will not have been updated yet. For correct behavior there has to be at least one instruction (nop) between the write to either R2_A2T or R2_T2A and the flag check. However, in practical programming terms this should not be a restriction.

7.7 Sample-rate convertor DSP (SDSP)

7.7.1 Function

This SDSP is used solely for sample-rate conversion of five separate inputs to one master output sample rate. The hardware supports five stereo inputs and outputs, the possible input and output sample-rate combinations depending on the DSP clock frequency.

The digital inputs are grouped into four independent I²S inputs, two SPDIF digital inputs and two I²S-like inputs from the TDSPs. All of these are stereo channels. Of these inputs, five can be routed through the SDSP and one can be selected directly as input for the ADSP. This means that six digital channels can be processed at the same time by the ADSP where the sixth direct input on the ADSP needs to be sample-rate converted in the ADSP. When a six-channel - i.e. three I²S channels - DVD source needs to be processed, I²S input 1, SPDIF1D_DVD34 and SPDIF2D_56 are used to cover all three stereo channels.

7.7.2 Flags

Six user flags are available for the software running in the SDSP, the stretch mode as well as the I/O direction of these flags being user-definable. A further six 'newsam' flags are used as sample indicators for the SRC software. These flags have stretch mode pre-set and are hard-wire coded, and therefore cannot be changed; only disabled or enabled using the corresponding I²C control bits. The function of each SDSP user flag is shown in Table 19.

| Chip pin name | Flag | Function | Mode | |
|---------------|------|------------------------------|------------|------------|
| | | | I/O | Stretch |
| - | F0 | Reference sample rate flag | IN | ON |
| - | F1 | Source 1 sample rate flag | IN | ON |
| - | F2 | Source 2 sample rate flag | IN | ON |
| - | F3 | Source 3 sample rate flag | IN | ON |
| - | F4 | Source 4 sample rate flag | IN | ON |
| - | F5 | Source 5 sample rate flag | IN | ON |
| ADSP_IOF6 | F6 | User-defined input or output | IN/OUT [1] | ON/OFF [1] |
| ASDP_IOF7 | F7 | User-defined input or output | IN/OUT [1] | ON/OFF [1] |
| ADSP_IOF8 | F8 | User-defined input or output | IN/OUT [1] | ON/OFF [1] |
| ADSP_IOF9 | F9 | User-defined input or output | IN/OUT [1] | ON/OFF [1] |

Table 19. SDSP user flag function

| Chip pin name | Flag | Function | Mode | |
|---------------|------|--------------------------------------|------------|------------|
| | | | I/O | Stretch |
| ADSP_IOF10 | F10 | User-defined input or output | IN/OUT [1] | ON/OFF [1] |
| ADSP_IOF11 | F11 | User-defined input or output | IN/OUT [1] | ON/OFF [1] |
| - | F12 | Out flag to the WDOG status register | IN/OUT [1] | ON/OFF [1] |

Table 19. SDSP user flag function

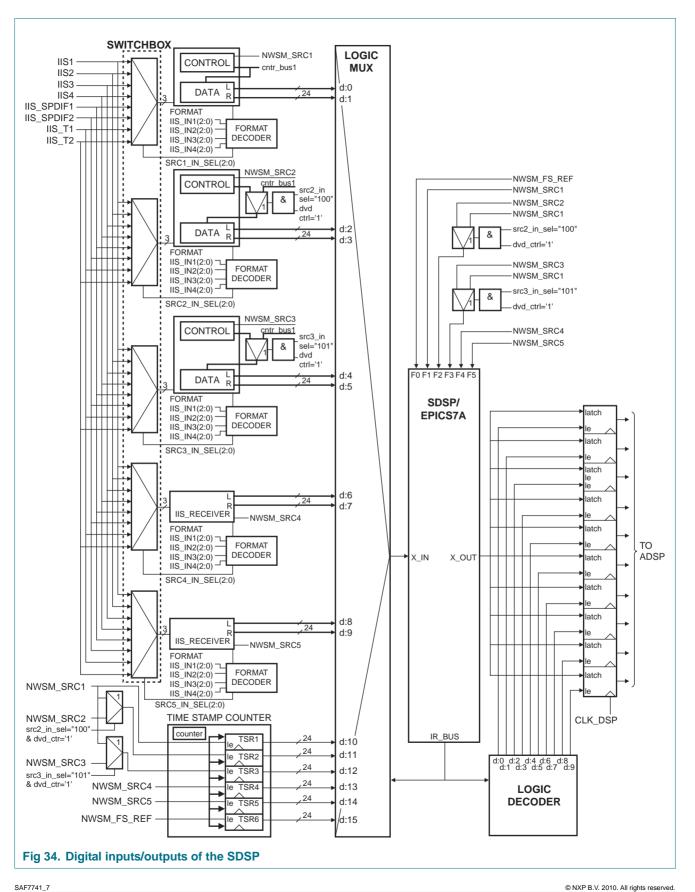
[1] I²C-controllable

7.7.3 DIO of the SDSP

For each stereo input one out of eight available stereo sources can be selected via a switchbox. The input format of each stereo DIO input can then be selected via an I^2C register. For the location of these bits see <u>Ref. 3</u>.

The I²C bits are controlled by the ADSP and the MPI. DIO inputs are also available for the registers that contain new sample timestamps of the five individual stereo inputs, and there is one extra register for the reference sample rate. Combined with the new-sample flags of the inputs and the reference flags, these timestamps allow the DSP program to convert the five sample rates to the reference on the output (see Figure 34).

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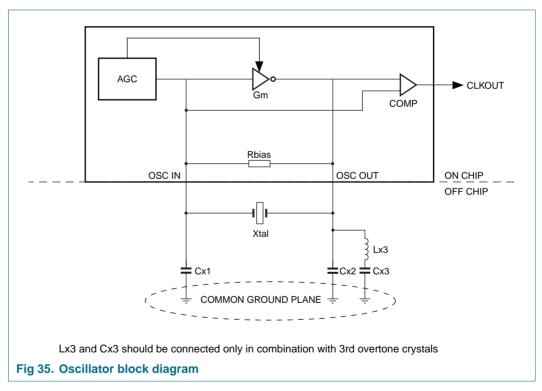
7.8 Common system descriptions

This section provides descriptions of certain functions and blocks that are not exclusively related to either the radio or the audio part of the SAF7741HV.

7.8.1 Oscillator

The SAF7741HV has a low-power Pierce oscillator with amplitude control and an inverter for the gain stage. The inverter biasing together with capacitive input coupling gives the gain stage Class C operation. When the circuit is oscillating there are sine waves at the input (osc_in) and at the output (osc_out) with V_{pp} close to the 1.8 V oscillator supply V_{dd}. The sine wave at the input and the output is converted by a low-jitter comparator into a CMOS-compatible clock.

The oscillator block diagram is shown in Figure 35. The crystal should be connected to the PCB as close as possible to the oscillator input and output pins of the chip. Care must also be taken to make sure that the load capacitors Cx1 and Cx2 and OSC_REF_N have a common ground plain. Loops must be made as small as possible in order to minimize noise coupling to the crystal nodes, and in addition parasitics should be kept as small as possible.



Lx3 and Cx3 have to be added when the crystal is used at the third overtone frequency. <u>Table 20</u> gives specifications for fundamental and third-overtone frequency crystals. C_L is the typical load capacitance of the crystal and is usually specified by the manufacturer. The actual C_L influences the oscillation frequency. Using a crystal manufactured for a different load capacitance will cause the circuit to oscillate at a slightly different frequency (dependent on the quality of the crystal) from the specified one. Therefore, to obtain an accurate time reference, it is advisable to use the load capacitors specified in <u>Table 20</u>. In addition to start-up problems, the use of values other than those quoted can lead to performance degradation due to an unstable clock reference.

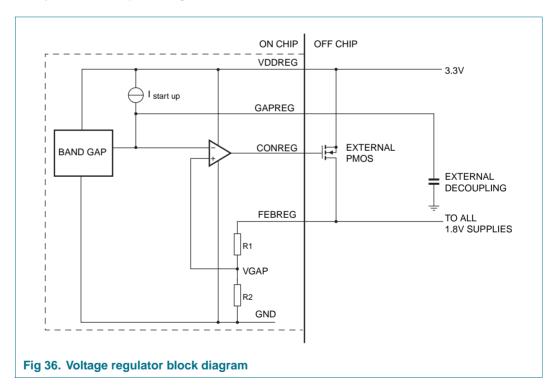
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| Name | Value | | |
|--|----------------|-------------|--|
| | Third overtone | Fundamental | |
| Maximum parallel capacitance (C _p) | 7 pF | 7 pF | |
| Load capacitance (C _I) | 10 pF | 10 pF | |
| Series resistance (R _s) | <60 Ω | <60 Ω | |
| C _{x1} | ≥12 pF | ≥8 pF | |
| C _{x2} | ≥12 pF | ≥8 pF | |
| C _{x3} | 10 nF | - | |
| L _{x3} | 2.2 μΗ | - | |

Table 20. Crystal parameters and external components

7.8.2 Voltage regulator

A voltage regulator controls all the 1.8 V supplies of the chip, with input from the 3.3 V supply. An external PMOS power transistor is used to handle power. The regulated 1.8 V supply is derived from a band-gap voltage AC-decoupled by an external capacitor so that a very accurate output voltage is obtained.



To speed up the settling time of the regulated supply voltage the external capacitor is charged with a larger current during start-up. When the voltage across the capacitor is close to the internal reference voltage this current is then switched off. A build in hysteresis makes sure that this current stays switched off during normal operation.

7.8.2.1 Power dissipation of the external transistor

Under worst-case conditions the total power dissipation of the external PMOS transistor is about the same as the power consumption of all the 1.8 V supplies. The application diagram in <u>Section 9</u> shows the voltage regulator application with the recommended PHK04P02T power transistor.

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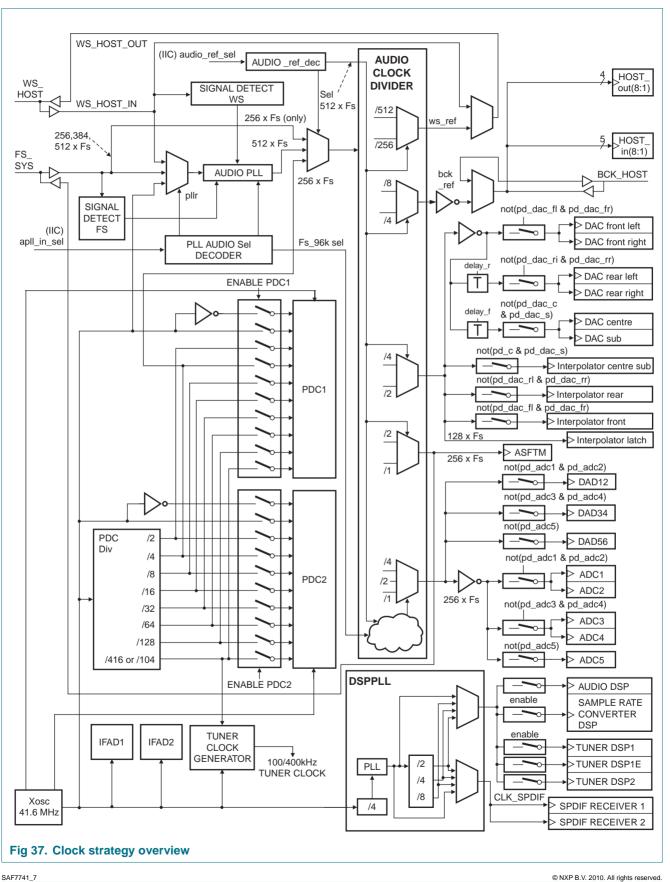
7.8.3 Clocking strategy

The overall clocking diagram is shown in <u>Figure 37</u>. The main clock source of the generated clock frequencies is the crystal oscillator running at 41.6 MHz. This generates the reference frequency for the:

- IFADC
- PDC
- DSP_PLL
- Audio PLL

The Audio PLL can also use either the FS_SYS pin or the WS_HOST pin as reference when the SAF7741HV is in slave mode.

Dual IF car radio and audio DSP (N1F)



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Generation of the DSP and other clocks

The SAF7741HV has two PLL circuits: one (DSP PLL) to generate the system clock for the DSPs and SPDIF receiver; the other (audio PLL) to generate the audio reference clocks. The crystal oscillator (radio rate), FS_SYS (external rate) or WS_HOST (audio rate) can be used as an input for the generation of the audio clocks. For the full setting ranges of the two PLLs see <u>Ref. 3</u>.

The DSP PLL is used to generate the clock to the DSPs and the SPDIF block.

The clock frequency of the SPDIF block should be chosen so that its relation to the sample rate of the incoming SPDIF Fs is $660 \times Fs < SPDIF CLOCK < 2480 \times Fs$.

For reasons of power reduction the clock to major blocks can be stopped separately. Exact bit definitions can be found in the CLK_EN register (\$000050) and APD_CTRL1 register (\$000040) of <u>Ref. 3</u>.

Audio clock generation is constructed in such a way that the ADSP can simultaneously process audio samples of 48 kHz and 96 kHz (i.e. double the sample rate frequency). These samples can be provided to the ADSP via the host inputs and received from the ADSP via the host outputs. For each host input or output a selection can be made between Fs or $\frac{1}{2} \times Fs$. Exact bit definitions can be found in Ref. 3.

When the SAF7741HV is in master mode the audio PLL is used to generate Fs from the crystal oscillator frequency of 41.6 MHz. Fs can be 44.1 kHz, 48 kHz or 96 kHz. When the SAF7741HV is in the slave mode the AUDIO_PLL can lock onto either WS_HOST or FS_SYS. If WS_HOST is used as an input its frequency can be 44.1 kHz, 48 kHz or 96 kHz. If FS_SYS pin is selected as the direct source for the internal audio clocks the maximum sample rate is limited to 48 kHz.

For the PDC blocks (PDC1 and PDC2) the clocks are derived digitally from the crystal oscillator frequency. The communication clock between SAF7741HV and the tuner IC can be either 100 kHz or 400 kHz. To reduce noise this tuner clock signal is sent to the tuner IC via a complementary current source. Frequency selection depends on the type of tuner connected to the SAF7741HV.

7.8.4 DSP PLL description

The oscillator frequency of 41.6 MHz is first divided by four, then fed to the DSP PLL. The DSP PLL output can be further divided by two, four or eight (depending on the I^2C settings) before being fed as the clock frequency to the DSP cores and the SPDIF block. A partial overview of the available frequencies is given in <u>Table 21</u>. The DSP PLL frequency is controlled via I^2C registers.

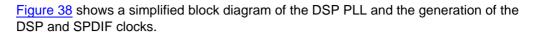
The output frequency of DSP PLL can be calculated with the formula:

$$F_{out} = 65 \times 10^4 \times (212 + MSEL) / 2^{(3 - \text{DSP}_\text{SEL})} \text{Hz}$$
 (1)

Where:

- MSEL = the decimal value of the dsp_pll_msel bits of the I²C CLKPLL_CTR register
- DSP_SEL = the decimal value of the dsp_sel bits of the I²C CLKPLL_CTR register

The default output frequency of the DSP PLL is 130 MHz.



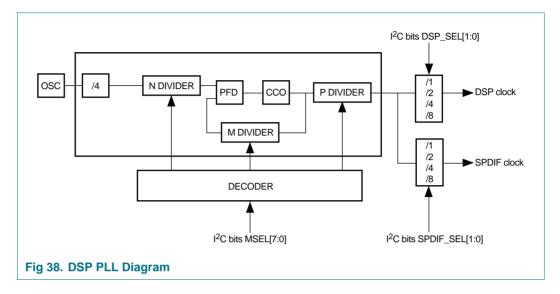


Table 21. Example of DSP PLL setting

| M-divider ratio | MSEL[7:0] | | Clock frequency (MHz) | | | | |
|--------------------|-----------|-------------------------------------|--------------------------------------|--------------------------------------|--------------------------------------|--|--|
| | | SPDIF_SEL=00 | SPDIF_SEL=01 | SPDIF_SEL=10 | SPDIF_SEL=11 | | |
| | | DSP_SEL=00 | DSP_SEL=01 | DSP_SEL=10 | DSP_SEL=11 | | |
| | | = M-divider ratio × 81.25 kHz | = M-divider ratio × 162.50 kHz | = M-divider ratio × 325.00 kHz | = M-divider ratio × 650.00 kHz | | |
| 212 | 0(0x00) | 17.225 | 34.450 | 68.900 | 137.800 | | |
| 213 | 1(0x02) | 17.306 | 34.612 | 69.225 | 138.450 | | |
| 214 | 2(0x03) | 17.387 | 34.775 | 69.550 | 139.100 | | |
| 390 | 178(0xB2) | 31.687 | 63.375 | 126.750 | 253.500 | | |
| 400 | 188(0xBC) | 32.50 | 65.00 | 130.00 | 260.00 | | |
| 420 | 208(0xD0) | 34.125 | 68.250 | 136.500 | 273.000 | | |
| 421 | 209(0xD1) | 34.206 | 68.412 | 136.825 | 273.650 | | |
| 422 | 210(0xD2) | 34.287 | 68.575 | 137.150 | 274.300 | | |

7.8.5 Audio PLL details

The audio PLL block is responsible for the generation of $512 \times Fs$ where Fs is the master sampling frequency. The audio PLL has three different inputs:

- Crystal oscillator input at 41.6 MHz. The audio PLL is preset automatically to the targeted frequencies of 512 × Fs for Fs = 44.1 kHz, Fs = 48 kHz and Fs = 96 kHz
- WS_HOST input. This is used to generate the 512 × Fs output frequencies for the following input sampling frequencies: Fs = 44.1 kHz, Fs = 48 kHz and Fs = 96 kHz
- FS_SYS input. This is used to generate the 512 \times Fs output frequencies for the following input frequencies: 256 \times Fs, 384 \times Fs and 512 \times Fs where Fs can be either 44.1 kHz or 48 kHz

To prevent the system from locking up when the WS_HOST or FS_SYS input drops out, the audio PLL switches automatically to the crystal oscillator input for generating the appropriate frequency. For example, if the WS_HOST input for Fs = 48 kHz drops out the audio PLL selects the crystal oscillator as input and generates the 512 × Fs output frequency with Fs = 48 kHz.

<u>Table 22</u> lists all the targeted output frequencies. The first column in the table gives the three possible inputs of the audio PLL while the second column lists the corresponding input frequencies. The third column shows the targeted sampling frequencies that are used to derive the output frequency of the PLL as shown in the last column of the table, i.e. $512 \times Fs$.

| Input signal | Input signal fre- quency | Targeted Fs (kHz) | Targeted output frequency = 512 × Fs |
|----------------------------|-----------------------------|-------------------|---|
| Osc: Oscillator (41.6 Mhz) | 41.6 MHz | 44.1 | 22.583 MHz |
| | 41.6 MHz | 48 | 24.576 MHz |
| | 41.6 MHz | 96 | 49.152 MHz |
| WS_HOST | 44.1 kHz | 44.1 | 22.579 MHz |
| | 48 kHz | 48 | 24.576 MHz |
| | 96 kHz | 96 | 49.152 MHz |
| FS_SYS | $256 \times Fs$ | 44.1 | 22.579 MHz |
| | $384 \times Fs$ | 44.1 | 22.579 MHz |
| | $512 \times Fs$ | 44.1 | 22.579 MHz |
| | $256 \times Fs$ | 48 | 24.576 MHz |
| | $384 \times Fs$ | 48 | 24.576 MHz |
| | $512 \times Fs$ | 48 | 24.576 MHz |
| | | | |

Table 22. List of frequencies generated by audio PLL

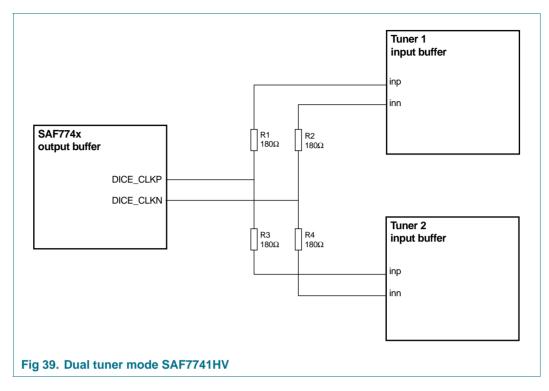
Remark: When the audio PLL is set to lock onto either WS_HOST or FS_SYS the actual frequency of the input signal is allowed to deviate by up to 20% from the target Fs. However, optimum audio performance of the SAF7741HV is guaranteed only at 44.1 kHz and 48 kHz.

7.8.6 Tuner clock generation circuit

To decrease total system cost, the crystal oscillator of SAF7741HV can also be used as reference clock for the tuner so that the external components of the the tuner's own crystal oscillator can be omitted. The technical advantage here is that the tuner and SAF7741HV clock frequencies are coupled, which prevents performance deterioration as a result of mismatched frequency domains.

The tuner clock generation circuit uses a differential output current to provide a 100 kHz/400 kHz reference clock. The reference frequency is derived from the crystal oscillator. To get rid of the disturbances introduced by the digital dividers, the clock for the current drivers is synchronized by the clean crystal oscillator clock. The differential output current ensures that the interface between the tuner and SAF7741HV will not interfere with the application. The output current depends on the number of connected tuners and needs to be controlled by I²C. See Figure 39 for the dual tuner application.

For the TEF6730 the reference clock frequency can be set to 100 kHz.



7.8.7 RESET sequence

The reset sequence is initiated by the RESETN pin going low, and will finish approximately 1.0 ms after the pin goes high again.

For a correct reset sequence initialization, the oscillator must be running and the oscillation must be stable. For small-pulse immunity the RESETN pin must be low during at least forty oscillator clock periods for a valid reset.

The total time between the RESETN pin going high and the reset sequence finishing is called the reset time, or tRESET, and is determined by the locking time of the PLLs. Once both PLLs are in lock the internal reset will stay active for another 2047 oscillator clock periods before the reset sequence completes. A reset will cause the chip to go into the initialization state.

When there is a reset the following actions are performed:

- All the bits of the I²C registers are set to their default values
- The DSP's program counter is reset to zero and kept there until the microprocessor writes the correct values to the DSP_CTR register (\$000010)
- The DSP's status registers are reset
- All DSP I/O flags are set to their default modes
- The IF processor block is reset
- The RDS decoder is reset
- The RS and I²C interfaces are reset
- The WDOG is reset

The RESETN pin is active low and has an internal pull-up function.

7.8.8 I²C interface

The I²C bus is for two-way, two-line-plus-ground communication between different ICs or modules. The two lines are the Serial Data Line (SDA) and the Serial Clock Line (SCL). The I²C interface allows access to:

- Radio settings
- PLL settings
- AD volume control
- DSP settings
- All DSP registers and memories

The chip acts as an I²C slave, so the SCL clock is input only while the SDA is a bi-directional line. Both standard-mode I²C (up to 100 kHz) and fast-mode I²C (up to 400 kHz) are supported.

7.8.8.1 I²C switch

The I²C switch enables communication with a secondary I²C bus connecting modules that are sensitive to digital noise. The switch is bi-directional and is controlled by the I²C block of the SAF7741HV. It has been designed specifically for an IF front-end chip for FM/AM reception that works with low voltages delivered by the antenna, and which is therefore easily disturbed by digital switching.

7.8.9 Watchdog (WDOG)

A Watchdog (WDOG) function has been added to each DSP to detect and signal operating faults. This feature increases the overall robustness of the system, but it cannot detect all DSP-related problems. The basic principle is that an instruction (mvi #FFFFFF, rmy0;) that will certainly not occur elsewhere is added to the DSP program. This instruction is inserted into the main software loop and will therefore be executed at regular intervals. To detect whether or not a DSP is running correctly an external circuit will check that the watchdog instruction has executed within a certain time slot. This slot is I2C-programmable to a maximum of 12.6 ms, and is therefore more than sufficient to accomodate the longest software loop.

The watchdog is disabled when the clock of a particular DSP is stopped or when a DSP is in reset.

The watchdog function offers a neat way of interrupting the external microcontroller. The function can also be used to allow the DSPs to interrupt the microcontroller under software control by means of output flag F12.

The interrupt output pad ADSP_IOF11 is connected to the WDOG logic and is combined with the ADSP I/O flag F11.

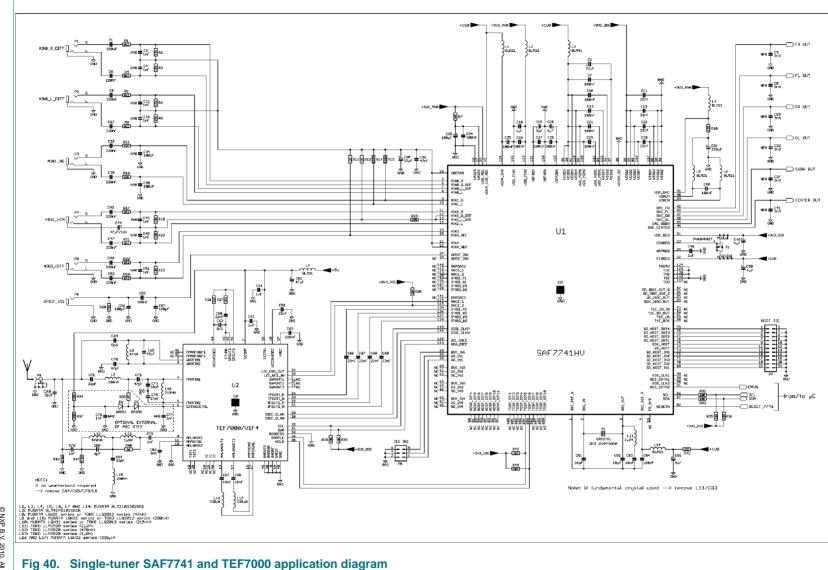
8. I²C memory map and bit definitions

The separate I²C Memory Map and Bit Definitions (Ref. 3) contains all the defined I²C bits and provides access to the memories of all the DSPs and the various registers throughout the whole system. It also provides access to the secondary I²C bus for communicating with the tuner.

To prevent EMC problems at the high-sensitivity tuner, normal I²C transmissions are not applied to the I²C bus that is connected to the tuner. Instead the SAF7741HV has a built-in I²C switch that becomes active the moment the so-called 'secondary I²C bus switch' address is written to, and which de-activates again the moment an I²C stop code is detected.

Application diagrams 9.





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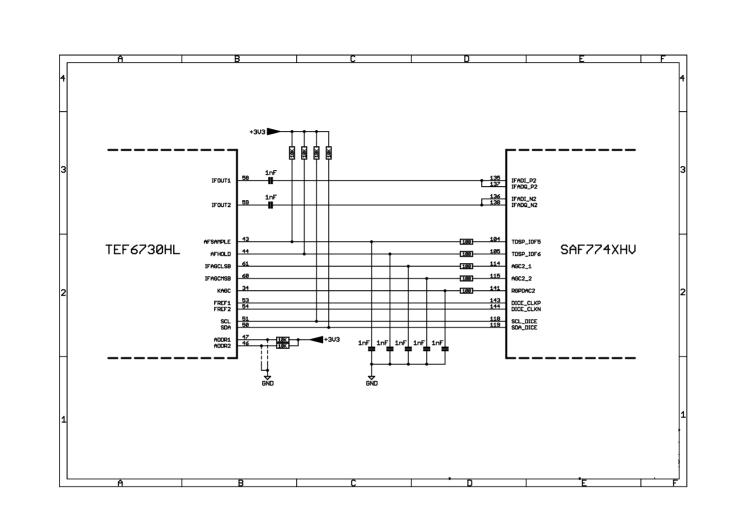


Fig 41. SAF774x and TEF6730 connections

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10. Limiting values

10.1 Electrical limiting values

Table 23. Electrical limiting values (in accordance with the Absolute Maximum Continuous Ratings system **IEC134)** Parameter Conditions Symbol Min Max Unit VDDD Supply voltage, internal rail -0.5 +2.5V VDDQ Supply voltage, external rail -0.5+4.6V (VDDQ + 2.5)Vi DC input voltage All inputs, except for IFAD inputs -0.5V or 5.5 V DC input voltage pins IFAD IFAD pins only -0.5VDDQ Vi ifad DC supply current per supply pin 100 mΑ -Isup DC ground current per ground pin _ 100 mΑ Ignd С Ambient operating temperature -40 +85 Tamb Storage temperature -40 +125С T_{sta} ESDS ESD sensitivity V Human body model pass voltage AEC - Q100-002 - REV-D 2000 _ level AEC - Q100-011 - REV-B C4 Charged device model pass Class voltage level LU Latch Up I-O trigger current JESD78A _ 100 mΑ V Latch Up VDD trigger voltage JESD78A $1.5 \times VDD_{max}$ -Total power dissipation 1600 mW P_{tot} -

11. Recommended operating conditions

| Table 24. | Operating conditions | | | | | |
|------------------|-------------------------------|------------|------|-----|------|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| VDDD | Supply voltage, internal rail | | 1.73 | 1.8 | 1.95 | V |
| VDDQ | Supply voltage, external rail | | 3.0 | 3.3 | 3.6 | V |
| T _{amb} | Ambient temperature | | -40 | - | +85 | С |

12. Thermal characteristics

|--|

| Symbol | Parameter | Conditions | Тур | Unit |
|---------------|---|--|-----|------|
| $R_{th(j-a)}$ | Thermal resistance from junction to ambient | Jedec 2S2P board with EPAD connection | 24 | K/W |

12.1 Thermal considerations in choosing a package

According to the worst-case simulations of the chip speed, the maximum allowable junction temperature is 125 °C. Reducing the thermal resistance of the system is therefore required, and a relatively effective way of doing this is to design an HLQFP144 with an exposed die-pad. The metal of the die-pad is exposed at the bottom of the package and

must be soldered onto a thermal land pattern. The exposed die-pad is used as extra ground pin in connection with the Kelvin capacitors (see Hardware description manual for details). The exposed dip-pad is connected with two types of copper plated PCB vias to a ground plane (see <u>Figure 47</u>). Soldering the die-pad onto the land pattern ensures that there is good thermal conductivity between the chip and the PCB, but there is little improvement to the thermal conductivity overall because power dissipation largely depends upon:

- The heat-radiating area
- The exposure of this area to the environment
- The thermal conductivity of heat-radiating/convecting material

That is why the thermal land pattern must be connected to a large ground plane by a number of vias that act as heat pipes. It is best to place the vias directly under the exposed die-pad as they are only 12 mil to 13 mil wide at a 1.2 mm pitch. These vias are exposed to the solder between the die-pad and the thermal land pattern. Making these vias only 12 mil to 13 mil wide will prevent solder wicking through the holes during reflow.

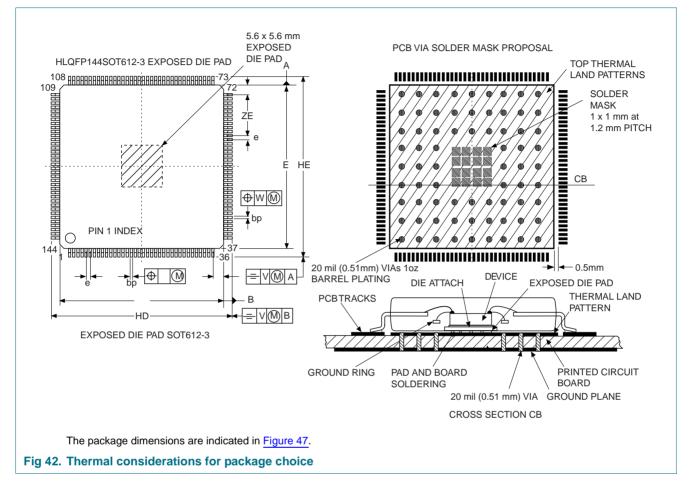
The solder mask is not one large mask with the same size as the exposed die-pad, but is sub-divided into 1.0 mm \times 1.0 mm large squares at a pitch of 1.2 mm. However, making vias of only 12 mil to 13 mil is expensive and here it is proposed to have the vias outside the solder area. These vias can be larger than 12 mil to 13 mil because these are not on a solder mask and are depicted here as 25 mil vias.

Thermally speaking, this is not the best solution but results in an acceptable thermal resistance. Taking the above mentioned considerations into account, it can be stated that the R_{thj-a} (thermal conductivity junction-to-ambient) of this package mounted on a particular PCB (with a specific ground plane area and plating thickness) will be known only after measuring the R_{thj-a} . The quality of the soldering of the die-pad to the land pattern, determines largely the R_{thj-a} , and some testing by the set maker needs to be done to be sure that in the production process automotive quality is guaranteed.

The following determine the total R_{thj-a} of this set-up:

- The thickness of the PCB (equal to the length of the plugged VIAs)
- The PCB material
- The number of conductive layers in the PCB
- The number of layers used to connect to the thermal VIAs
- · The thickness of the copper plating
- The copper area exposed to the outside world

Normally, 70% of the IC power is dissipated via the PCB. This could increase to 90% by using the exposed soldered die-pad solution.



12.2 Thermal considerations in choosing a package for the SAF7741HV production chip

13. Static characteristics

13.1 Supply currents

Table 26. Current for each supply pin or pin group

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------|---|--|-----|-----|-----|------|
| IP_DIG | DC supply current of the digital core, pins $VDDD_x$. Supply voltage 1.8 V (typical), 1.95 V (max) | High activity of the DSPs at 135.2 MHz DSP frequency | - | 220 | 290 | mA |
| IP_MEM | DC supply current of the memories, pins VDD_MEM _x . Supply voltage 1.8 V (typical), 1.95 V (max) | High activity of the DSPs at 135.2 MHz DSP frequency | - | 100 | 120 | mA |
| IP_IO | DC supply current of the periphery, pins $VDDQ_x$. Supply voltage 3.3 V (typical), 3.6 V (max) | Without an external load to ground | - | 2.5 | 8.0 | mA |
| IP_ANA18 | Supply current of the analog 1.8 V of IFADC, pin VDDA_1V8. Supply voltage 1.8 V (typical), 1.95 V (max) | | - | 1.6 | 4.0 | mA |

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------|---|---|-----|-----|------|------|
| IP_ADC18 | Supply current of the analog 1.8 V of audio ADC, pin VDDA_1V8_ADC. Supply voltage 1.8 V (typical), 1.95 V (max) | | - | 15 | 19 | mA |
| IP_AD | Supply current of the audio ADCs and SPDIF bitslicer, pin VDD_ADC. Supply voltage 3.3 V (typical) 3.6 V (max) | At zero input signal and zero output signal | - | 18 | 23 | mA |
| IP_VADCP | Supply current of the audio ADCs and RGP DAC, pin VADCP. Supply voltage 3.3 V (typical), 3.6 V (max) | | - | 0.5 | 0.7 | mA |
| IP_IFADC | Supply current of the IFADCs and RGP DAC, pin VDD_IFADC. Supply voltage 3.3 V (typical), 3.6 V (max) | | - | 27 | 35 | mA |
| IP_VDDDAC | Supply current of the DAC, pin VDD_DAC. Supply voltage 3.3 V (typical) | At zero input and output signal | - | 0.7 | 1.2 | mA |
| IP_VDACP | Supply current of the DAC, pin VDACP. Supply voltage 3.3 V (typical), 3.6 V (max) | At zero input and output signal | - | 5.6 | 7.3 | mA |
| IP_XTAL | Supply current XTAL oscillator, tuner clock generator and PLLs, pin OSC_REF. Supply voltage 1.8 V (typical), 1.95 V (max) | OSC functional mode at 41.6 MHz and a C _{load} = 10 pF. PLLs at default settings. | - | 3.2 | 4.1 | mA |
| IP_REG | Supply current regulator, pin VDD_REG. Supply voltage 3.3 V (typical), 3.6 V (max) | Functional mode | - | 0.4 | 0.52 | mA |
| P _{tot} | Total power dissipation | High activity of the DSPs at 135.2 MHz | - | 800 | 1125 | mW |

Table 26. Current for each supply pin or pin group ... continued

13.2 DC characteristics

Table 27. DC characteristics digital I/O (at T_{amb} = -40°C to +85 °C, V_{DDQ} = 3.3 V unless otherwise stated)

| | 0 | | | | | |
|-------------------|---|---|---------------|-----|------|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| VDDD | Operating supply voltage 1.8 V analog and digital | All VDD pins with respect to V_{ss} all parts | 1.73 | 1.8 | 1.95 | V |
| VDDQ | Operating supply voltage 3.3 V peripheral | All VDDQ pins with respect to $V_{\mbox{\scriptsize ss}}$ all parts | 3.0 | 3.3 | 3.6 | V |
| VIH | High level, input voltage | All digital inputs and I/Os | 2.0 | - | - | V |
| VIL | Low level, input voltage | All digital inputs and I/Os | - | - | 0.8 | V |
| V _{hyst} | Input hysteresis voltage | All digital inputs and I/Os | 0.4 | - | - | V |
| VOH | Static output, high voltage | All digital inputs and I/Os | VDDQ - 0.4 | - | - | V |
| VOL | Static output, low voltage | All digital inputs and I/Os | - | - | 0.4 | V |
| IOZ | 3-state leakage current towards | Input voltage < VIL | - | -1 | - | μΑ |
| | either VSSQ or VDDQ | Input voltage > VIH | - | 1 | - | μΑ |
| | | VIL < input voltage < VIH | - | 20 | - | μΑ |
| IOSH | Short circuit current, output high | Drive high. Pad connected to ground | - | - | 40 | mA |
| IOSL | Short circuit current, output low | Drive low. Pad connected to VDDQ | - | - | 45 | mA |
| I _{PU} | Pull-up current | $V_i = 0.0 V$ | - | -50 | - | μA |
| I _{PD} | Pull-down current | V _i = 3.3 V | - | 50 | - | μA |
| | | | | | | |

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| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|---|---|---------------|-----|---------------|------|
| C _{IN} | Input capacitance | Including bond pads | - | - | 3 | pF |
| I ² C pads | | | | | | |
| VIL | Low level input voltage | | -0.5 | - | 0.3 × VDDQ | V |
| VIH | High level input voltage | | 0.7 × VDDQ | - | VDDQ + 0.5 | V |
| V _{hys} | Hysteresis voltage | | 0.1 × VDDQ | - | - | V |
| IOL | Low level output current | At $V_{OL} = 0.4V$ | 3 | - | - | mA |
| IOH | High level output current | $0.3 \times \text{VDDQ} < \text{V}_{OH} < 0.7 \times \text{VDDQ}$ | 3 | - | 12 | mA |
| Miscellar | neous | | | | | |
| t _{RESET} | Time when the device is ready for use after the rising edge of the RESETN pin | All power supply voltages are within the specified values | - | 0.6 | 2 | ms |
| I _{ddq} | Digital quiescent (not active) current | VDDD = 1.95 V VDDQ = 3.6 V | - | - | 2000 | μA |

14. Dynamic characteristics

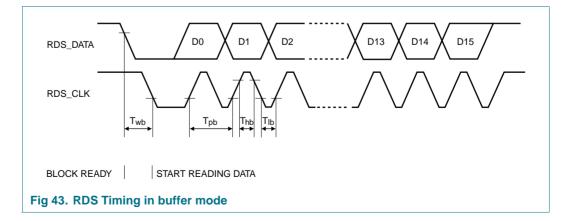
| Table 28. Digital pins timing characteristics | | | | | | |
|---|---|------------|-----|-----|-----|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| t _{RF} | Output rise/fall time digital pads non slew-rate controlled | [1] | 2.5 | - | 5.5 | ns |
| t _{RF_SC} | Output rise/fall time digital pads slew-rate controlled | [1] | | 10 | | ns |
| F _{MAX} | Maximum operating frequency | <u>[1]</u> | - | - | 50 | MHz |

[1] Output load = 30 pF. Measurement criteria is 10% to 90%.

14.1 RDS electrical specification

Remark: Refer to <u>Ref. 1</u> for the timing figure in Direct Output mode.

Figure 43 shows the timing of the interface signals in buffer mode.



| | ······································ | | | | |
|--------------------|--|-----|--------|-----|------|
| Symbol | Parameter | Min | Тур | Max | Unit |
| F _{rdscl} | Nominal clock frequency of the RDS clock | - | 1187.5 | - | Hz |
| T _{wb} | Wait time | 1 | - | - | μs |
| T _{pb} | Periodic time | 2 | - | - | μs |
| T _{hb} | Clock high-time | 1 | - | - | μs |
| T _{lb} | Clock low-time | 1 | - | - | μs |
| F _{excl} | Input frequency External RDSA Clock | - | - | 10 | MHz |
| | | | | | |

Table 29. Timing of the RDS interface (see Figure 43)

14.2 Digital radio output

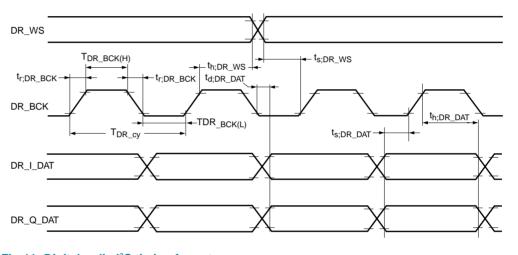
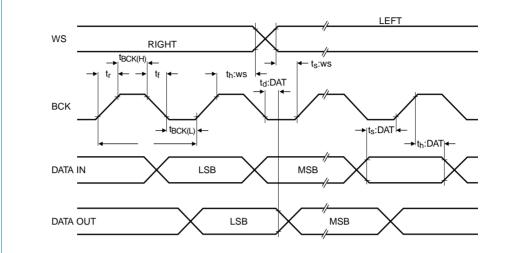


Fig 44. Digital radio I²S timing format

Table 30. Timing digital radio outputs

| Symbol | Parameter | Min | Тур | Max | Unit |
|------------------------|------------------------|-----|-------|-----|------|
| T _{DR_cy} | Bitclock cycle time | - | 96.15 | - | ns |
| t _{r;DR_BCK} | Rise time | - | - | 14 | ns |
| t _{r;DR_BCK} | Fall time | - | - | - | ns |
| T _{DR_BCK(H)} | Bitclock time HIGH | 34 | - | - | ns |
| T _{DR_BCK(L)} | Bitclock time LOW | 34 | - | - | ns |
| t _{s;DR_DAT} | Data setup time | 19 | - | - | ns |
| t _{h;DR_DAT} | Data hold time | 19 | - | - | ns |
| t _{d;DR_DAT} | Data delay time | - | - | 14 | ns |
| t _{s;DR_WS} | Word select setup time | 19 | - | - | ns |
| t _{h;DR_WS} | Word select hold time | 19 | - | - | ns |

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14.3 IIS timing specification

Fig 45. Input timing of the digital audio data inputs and the digital audio data outputs

| Symbol | Parameter | Min | Max | Unit |
|---------------------|-------------------------|---------------------|---------------------|------|
| T _{cy} | Bitclock cycle time | 162 | - | ns |
| t _r | Rise time | - | $0.15\times T_{cy}$ | ns |
| t _f | Fall time | - | $0.15\times T_{cy}$ | ns |
| t _{BCK(H)} | Bitclock time HIGH | $0.35\times T_{cy}$ | - | ns |
| t _{BCK(L)} | Bitclock time LOW | $0.35\times T_{cy}$ | - | ns |
| t _{s;DAT} | Data set-up time | $0.2\times T_{cy}$ | - | ns |
| t _{h;DAT} | Data hold time | $0.2\times T_{cy}$ | - | ns |
| t _{d;DAT} | Data delay time | - | $0.15\times T_{cy}$ | ns |
| t _{s;WS} | Word select set-up time | $0.2\times T_{cy}$ | - | ns |
| t _{h;WS} | Word select hold time | $0.2 	imes T_{cy}$ | - | ns |
| | | | | |

Table 31. Timing digital audio inputs and outputs (see Figure 45)

14.4 I²C electrical specifications

14.4.1 I²C timing

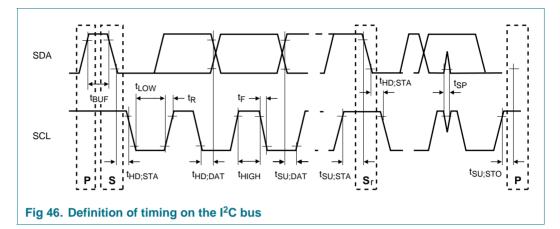


Table 32. Timing I²C bus, see Figure 46

| Symbol | Parameter | Conditions | Standard Mode I ² C Bus | | Fast M I ² C Bu | | Unit |
|---------------------|--|-------------|---------------------------------------|-----|-------------------------------|-----|------|
| | | | Min | Max | Min | Max | |
| f _{SCL} | SCL clock frequency | | 0 | 100 | 0 | 400 | kHz |
| t _{BUF} | Bus free between a STOP and a START condition | | 4.7 | - | 1.3 | - | μs |
| t _{HD:STA} | Hold time (repeated) START condition. After this period, the first clock pulse is generated | | 4.0 | - | 0.6 | - | μS |
| t _{LOW} | LOW period of the SCL clock | | 4.7 | - | 1.3 | - | μS |
| t _{HIGH} | HIGH period of the SCL clock | | 4.0 | - | 0.6 | - | μS |
| $t_{\rm SU:STA}$ | Set-up time for a repeated START condition | | 4.7 | - | 0.6 | - | μS |
| t _{HD:DAT} | DATA hold-time | | 0 | - | 0 | 0.9 | μS |
| t _{SU:DAT} | DATA set-up time | | 250 | - | 100 | - | ns |
| t _r | Rise time of both SDA and SCL signals ^[1] | C_b in pF | 20 + 0.1C _b | 300 | 20 + 0.1C _b | 300 | ns |
| t _f | Fall time of both SDA and SCL signals [1] | C_b in pF | 20 + 0.1C _b | 300 | 20 + 0.1C _b | 300 | ns |
| t _{SU;STO} | Set-up time for the STOP condition | | 4.0 | - | 0.6 | - | μS |
| Cb | Capacitive load for each bus line | | - | 400 | - | 400 | pF |
| t _{SB} | Pulse width of the spikes to be suppressed by the input filter | | 0 | 80 | 0 | 80 | ns |

[1] Measurement criteria is 30% to 70%.

14.5 SPDIF

| Table 33. | Analog SPDIF characteristics (conditions: Tamb = 25°C, unless otherwise stated) | | | | | | |
|---------------|---|-------------------------|-----|-----|-----|-----------------|--|
| Symbol | Parameters | Conditions | Min | Тур | Max | Unit | |
| VDD_SPD IF | Supply voltage for the SPDIF | | 3.0 | 3.3 | 3.6 | V | |
| SPVL | AC input level | | 0.2 | - | 3.6 | V _{pp} | |
| SPIR | Input resistance | $f_i = 1.0 \text{ kHz}$ | 5.5 | 8.5 | 14 | kΩ | |
| SPIC | Input capacity | | - | 50 | - | pF | |
| SPHYS | Hysteresis input | | 30 | 40 | 55 | mV | |
| SPCIN | Input couple capacitor | | - | 10 | - | nF | |

14.6 Audio ADC

Table 34. Audio ADC DC characteristics (conditions: T_{amb} = 25°C, unless otherwise stated)

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|--------------|---|--------------------------------|------|------|------|--------|
| VDDA_1v8_ADC | Supply voltage analog part ADCs | | 1.73 | 1.80 | 1.95 | V |
| VDD_ADC | Supply voltage analog part ADCs | | 3.0 | 3.3 | 3.6 | V |
| VREFAD | Common mode output reference voltage ADCs | With respect to VADCP/VADCN | 47 | 50 | 53 | %VADCP |
| ZOUT | Output impedance VREFAD | l _{out} <2 mA | - | 10 | 100 | Ω |
| VADCP | Positive input reference voltage ADCs and RGPDAC | | 3.0 | 3.3 | 3.6 | V |
| VADCN | Negative input reference voltage ADCs and RGPDAC | | -0.3 | 0 | 0.3 | V |
| IVADCN | Negative input reference current ADCs and RGPDAC | | - | 370 | - | μA |

Table 35. Audio ADC AC characteristics (conditions: T_{amb} = 25°C, VDD_ADC = 3.3 V, VDDA_1v8 = 1.8 V, VADCP/VADCN = 3.3 V, Fs = 44.1 kHz, unless otherwise stated)

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|--------|-------------------------------------|--|-----|-----|-----|------|
| AILVL | Conversion input level at ADC input | <1% Total Harmonic Distortion (THD) | - | - | 0.7 | Vrms |
| AIIRG | Input resistance AIN0 to AIN4 | | 1 | - | - | MΩ |
| AITHDC | THD+N AIN0 to AIN4 inputs | 1 kHz, 0.5 V _{rms} , BW = 20 kHz | - | -82 | -76 | dB |
| AISNRC | SNR AIN0 to AIN4 inputs | 1 kHz, BW = 20 kHz, 0 dB ref. = 0.5 V _{rms} | 85 | 92 | - | dBA |

| VADCP/VADCN = 3.3 V, Fs = 44.1 kHz, unless otherwise stated) | | | | | | | |
|--|--------------------------------|--|-----|-----|-----|------|--|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit | |
| AICRI | Crosstalk between inputs | 1 kHz, 0.5 V _{rms} , measured input ac grounded | 65 | - | - | dB | |
| | | 15 kHz, 0.5 V_{rms} , measured input ac grounded | 50 | - | - | dB | |
| CMRRCD | CMRR high common mode | AIN0_R_GND = 1 M Ω , RCD Player GND cable = <1 k Ω , F _{in} = 1 kHz, 100 mV _{rms} | 60 | - | - | dB | |
| B_ADC | Audio input frequency response | –3 dB roll-off, Fs = 44.1 kHz | 20 | - | - | kHz | |

Table 35. Audio ADC AC characteristics (conditions: Tamb = 25°C, VDD ADC = 3.3 V, VDDA 1v8 = 1.8 V.

14.7 IFADC

Table 36. IFADC DC Characteristics (conditions: $T_{amb} = 25^{\circ}C$, unless otherwise stated)

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------|---|---------------------------|------|------|------|------|
| VDDA_1v8 | Supply voltage analog part IFADC | | 1.73 | 1.80 | 1.95 | V |
| VDD_IFADC | Supply voltage analog part IFADC and RGPDAC | | 3.0 | 3.3 | 3.6 | V |
| VIFADCP | Positive output reference voltage IFADC | | 2.65 | - | 3.0 | V |
| VIFADCN | Negative input reference voltage IFADC | | -0.3 | 0 | +0.3 | V |
| VIFADCBG | Band gap output reference voltage IFADC | | 1.15 | 1.26 | 1.30 | V |
| IF_INPR | Single ended input resistance IFADC in low IF mode | TEF7000 tuner application | 16.5 | 20.9 | 25 | kΩ |
| | Single ended input resistance IFADC in normal IF mode | TEF6730 tuner application | 50 | 62.2 | 75 | kΩ |

Table 37. IFADC AC Characteristics in low IF mode (conditions: T_{amb} = 25°C, VDD_IFADC = 3.3 V, VDDA_1v8 = 1.8 V, unless otherwise stated)

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------|---|---|-----|-----|-----|------|
| LIF_CNR3k | Carrier-to-Noise ratio total IF | 1.4 V _{pp} input IFADC, bandwidth 3 kHz, typical application running | 90 | 100 | - | dB |
| LIF_DNR | Dynamic range IF | V _{dif} = 0.5 V _{rms} BW = 3.0 kHz | 95 | 102 | - | dB |
| LIF_IM6 | Third order inter-modulation with –6 dB signals IF | Two –6 dB signals at 300 kHz and 305 kHz, with respect to 0.0 dB level | - | -88 | _ | dB |
| LIF_IM9 | Third order inter-modulation with –9 dB signals IF | Two –9 dB signals at 300 kHz and 305 kHz, with respect to 0.0 dB level | - | -92 | _ | dB |
| LIF_IR | Image rejection IF | Two input signals that have a 90° phase shift and equal gain | 45 | 50 | - | dB |

Table 38.IFADC AC Characteristics in normal IF mode (conditions: T_{amb} = 25°C, VDD_IFADC = 3.3 V, VDDA_1v8 =1.8 V, unless otherwise stated)

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------|---|--|-----|-----|-----|------|
| IF_CNR3k | Carrier-to-Noise ratio total IF | 1.4 V _{pp} input IFADC,bandwidth 3 kHz; typical application running | - | 95 | - | dB |
| IF_DNR | Dynamic range IF | V_{dif} = 0.5 V_{rms} BW = 3.0 kHz | - | 97 | - | dB |
| IF_IM6 | Third order inter-modulation with -6 dB signals IF | Two -6 dB signals ^[1] at 10.71MHz and 10.705MHz, with respect to 0.0 dB level | - | -81 | - | dB |
| IF_IM9 | Third order inter-modulation with -9 dB signals IF | Two -9 dB signals ^[1] at 10.71MHz and 10.705MHz, with respect to 0.0 dB level | - | -89 | - | dB |
| IF_IR | Image rejection IF | Two input signals that have a 90° phase shift and equal gain | 45 | 50 | - | dB |

[1] The two signals are at 10.700 MHz and 10.705 MHz.

14.8 Voltage regulator

Table 39. Analog regulator characteristics (conditions: T_{amb} = 25°C, unless otherwise stated)

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------|---|--------------------------------|------|-------|-----------------|------|
| VDD_REG | Supply voltage regulator | | 3.0 | 3.3 | 3.6 | V |
| GAPREG | Band gap output reference voltage regulator | | - | 1.246 | - | V |
| VFEBREG | Voltage at the pins FEBREG | PMOST PHK04P02T in application | 1.82 | 1.91 | 1.95 | V |
| VCONREG | Regulator control range | VDD_REG = 3.3 V | 0.5 | - | $VDD_REG - 0.3$ | V |
| REGSU | Start-up time regulator | | - | 0.5 | see [1] | ms |

[1] Dependent on the external components.

14.9 Audio DAC (ADAC)

Table 40. Audio DAC DC characteristics (conditions: T_{amb} = 25°C, unless otherwise stated)

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------|--|--|------|-----------|------|------|
| VDD_DAC | DAC digital power supply | | 3.0 | 3.3 | 3.6 | V |
| VDACP | Positive input reference voltage DAC | | 3.0 | 3.3 | 3.6 | V |
| VDACN | Negative input reference voltage DAC | | -0.3 | 0 | +0.3 | V |
| VOUT_DC | Average DC output voltage | R_{load} >20 k Ω AC coupled only | - | VDACP / 2 | - | V |
| ROUTDA | DAC output resistance | | 0.7 | 1.0 | 1.3 | kΩ |
| RREFDA | Resistance between VDACP and VDACN | | - | 0.66 | - | kΩ |
| ISCDA | Output short-circuit current DAC | | - | - | 5.2 | mA |
| В | Bandwidth DA (Roll-off due to internal DA source resistance and external capacitor / load) | At -3.0 dB, C _{fil} = 3.3 nF NPO | - | 48 | - | kHz |

Table 40. Audio DAC DC characteristics (conditions: T_{amb} = 25°C, unless otherwise stated)

| | • | | | , | | |
|----------|--|------------------------------|-----|-----|-----|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| B_DAC | Roll-off due to internal DAC filter | At -3.0 dB, Fs = 44.1 kHz | 20 | - | - | kHz |
| DAC-CFIL | Filter capacitance on DAC outputs | NPO capacitor used | - | 3.3 | - | nF |
| DAC-RL | Allowed load resistor on DAC voltage outputs | AC coupled only | 20 | - | - | kΩ |

Table 41.Audio DAC AC characteristics (conditions: $T_{amb} = 25^{\circ}C$, VDD_DAC = 3.3 V, VDACP / VDACCN = 3.3 V,
Rload AC = 20 k Ω , Fs = 44.1 kHz, unless otherwise stated)

| | | · · · | | | | |
|-------------------|---|---|------|-----|------|------------------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| VOUT_AC | Output voltage AC of Op-Amp outputs at full I^2S signal | | 0.95 | 1.0 | 1.10 | V _{rms} |
| PSRRDA | Reference power supply Ripple Rejection DACs | $\label{eq:ripple} \begin{split} F_{ripple} &= 1.0 \text{ kHz}, \\ V_{ripple} &= 100 \text{ mV}_{peak}, \\ CVDACP &= 220 \mu\text{F} \end{split}$ | 3 | 6 | - | dB |
| UNBAL | Deviation in output level of one of the six DAC outputs with respect to the average of the six outputs | Full-scale output | - | - | 0.2 | dB |
| ХТ | Channel separation between the outputs in the audio band. Front or Rear outputs digital silence, others maximum volume | f _i = 1.0 kHz | 74 | 86 | - | dB |
| THD and N/S | DAC total harmonic distortion plus noise, versus Output signal DAC | f _i = 1.0 kHz, –0.2 dB C _{fil} = 3.3 nF NPO | - | -78 | -70 | dB |
| THD and N/S 60 | DAC total harmonic distortion plus noise, versus Output signal DAC at -60 dB | f _i = 1.0 kHz, –60 dB, C _{fil} = 3.3 nF NPO | - | -45 | -40 | dBA |
| SNR | Signal-to-Noise ratio. This is the dB ratio between the full I ² S signal and the I ² S digital silence noise | | 100 | 106 | - | dBA |
| IM | Intermodulation distortion | $f_i = 60 \text{ Hz and 7 kHz},$ ratio = 4:1 | - | -70 | -55 | dB |

14.10 RGPDAC

Table 42.RGPDAC DC Characteristics (conditions: T_{amb} = 25°C, unless otherwise stated)

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------|---|------------|---------------------|-----|------------------------|------|
| VDD_IFADC | Supply voltage analog part IFADC and RGPDAC [1] | | 3.0 | 3.3 | 3.6 | V |
| VADCP | Positive output reference voltage Audio ADC ^[2] | | 3.0 | 3.3 | 3.6 | V |
| VADCN | Negative input reference voltage Audio ADC [2] | | -0.3 | 0 | 0.3 | V |
| DCR_RDA | DC output voltage range RGPDAC | | VSS_IFA DC + 0.3 | - | VDD_IF ADC - 0.3 | V |

| Table 42. | RGPDAC DC Characteristics (conditions: $T_{amb} = 25^{\circ}C$, unless otherwise stated) | | | | | |
|-----------|---|--|-----|-----|-----|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| ISC_RDA | Output short circuit current RGPDAC | Output short circuit current to ground at maximum positive output DC voltage | - | - | 120 | mA |
| RL_RDA | Resistive load RGPDAC | | 50 | - | - | kΩ |
| CL_RDA | Capacitive load RGPDAC | | - | - | 200 | pF |
| | | | | | | |

. . . .

[1] These are the same values as those given in Table 36. They have been added here because the same supply pins are connected to the Audio AD and to the RGPDAC.

These are the same values as those given in Table 34. They have been added here because the same supply pins are connected to the [2] Audio ADC and to the RGPDAC.

Table 43. RGPDAC AC Characteristics (conditions: T_{amb} = 25°C, VDD_IFADC = 3.3 V, unless otherwise stated)

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------|---|---|-----|------|-----|---------------|
| R_RDA | Resolution of RGPDAC | | - | 10 | - | bits |
| INL_RDA | Integral non-linearity RGPDAC | F = 1.0 kHz, Sampling rate = 400 kHz | - | 2.5 | 7 | LSB levels |
| DNL_RDA | Differential non-linearity RGPDAC | F = 1.0 kHz, Sampling rate = 400 kHz | - | 1.25 | 2.5 | LSB levels |
| PSRR_RDA | Power supply Ripple Rejection RGPDAC | F _{ripple} = 1.0 kHz, V _{ripple} = 100 mV _{peak} peak | 43 | 48 | - | dB |
| FS_RDA | Sample rate of RGPDAC | | - | - | 400 | kHz |

14.11 Tuner clock generator

Table 44. Tuner clock generator characteristics (conditions: T_{amb} = 25°C, VDD_1V8 = 1.8 V, unless otherwise stated)

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------|---------------------------------|---|-----|----------------|-----|------|
| Tcg_Clock | Clock output frequency | | - | 400/100 [1] | - | kHz |
| Tcg_Cur | Output current sourcing/sinking | Single tuner mode | 200 | 300 | 400 | μΑ |
| | | Dual tuner mode | 400 | 600 | 800 | μA |
| Tcg_ICM | Common mode output current | From each pin to ground | -50 | - | 50 | μΑ |
| Tcg_V _{out} | DC level at the outputs | DC level will be determined by the load current | 1.0 | 1.2 | 1.4 | V |
| Tcg_Load | Load impedance | | - | 180 | - | Ω |

[1] Depends on the type of the tuner connected to the SAF774x

14.12 Oscillator

Table 45. Oscillator characteristics (conditions: T_{amb} = 25°C [1], unless otherwise stated)

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|--------|-----------------------------------|------------|------|-----|------|------|
| | Supply voltage crystal oscillator | | 1.73 | 1.8 | 1.95 | V |
| | and PLL | | | | | |

| Table 45. | Oscillator characteristics (condition | ons: T _{amb} = 25°C [<u>1]</u> , unless otherwise st | ated) | | | |
|-----------|---------------------------------------|--|-------|------|------|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| XTFREQ | Crystal frequency | C _{load} = 10 pF, 3rd overtone | - | 41.6 | - | MHz |
| | Adjustment tolerance | $T_{amb} = 25^{\circ}C$ | -50 | - | +50 | ppm |
| | Temperature drift for WX applications | | -30 | - | +30 | ppm |
| | Temperature drift AM/FM applications | | -50 | - | +50 | ppm |
| | Aging drift (all applications) | | -5 | - | +5 | ppm |
| XLOAD | Load capacitance | | - | 10 | - | pF |
| RXTAL | Allowed loss resistor of the crystal | C _{load} = 10 pF | - | - | 60 | Ω |
| CPXTAL | Parallel package capacitance | | - | - | 7 | pF |
| XROUT | Oscillator output impedance | AC method: V_{im} = 20 mV _{rms} @ 1.0 MHz | 600 | - | 1100 | Ω |
| | | DC method: V_{im} = 600 mV _{rms} @ DC | 1350 | - | 3150 | W |
| XGM | Oscillator trans conductance | AC method: V_{im} = 20 mV _{rms} @ 1.0 MHz | 13 | 24 | 35 | mA/V |
| | | DC method: $V_{im} = 600 \text{ mV}_{rms} \oplus DC$ | 13 | - | 22 | mA/V |
| | | | | | | |

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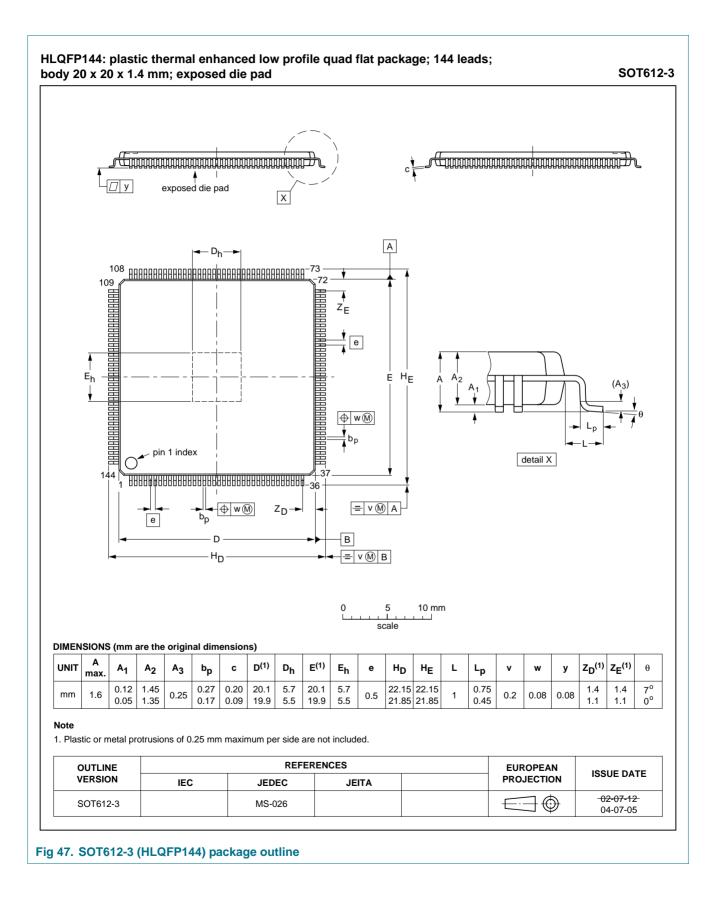
[1] The oscillator can operate within a temperature range of -40° C to 85° C.

15. Package outline

The package outline for the SAF7741HV is a SOT612-3 (HLQFP144). The outer dimensions are 20 mm \times 20 mm \times 1.4 mm (see Figure 47).

The sub-package has a double down set with an exposed die-pad of $5.6 \text{ mm} \times 5.6 \text{ mm}$ and a ground ring at a higher level that is connected mechanically to the exposed die-pad. Lead number 98 is a fused lead to this ground ring.

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Dual IF car radio and audio DSP (N1F)

16. Abbreviations

| Table 46. | Abbreviations |
|------------------|--|
| Acronym | Description |
| ADC | Analog-to-Digital Converter |
| ADF | Audio Decimation Filter |
| ADSP | Audio DSP |
| AF | Alternate Frequency |
| AFC | Automatic Frequency Control |
| AGC | Automatic Gain Control |
| AM | Amplitude Modulation |
| A/S-DSP | Audio/Sampled DSP |
| BCK | Bit-Clock |
| BSLP | Bit–Slip |
| BSPA | Bit–Slip Process Active |
| CD | Compact Disc |
| CIC | Cascaded Integrator Comb filter Carrier Identification Code |
| CLK | Clock |
| CMOS | Complementary Metal Oxide Semiconductor |
| CMRR | Common Mode Rejection Ratio |
| CRD | Cordic Rate and De-rotate |
| DAC | Digital-to-Analog Converter |
| DAD | Audio DAC Decimation |
| DAVB | Digital Audio and Video Broadcasting |
| DAVN | Data Available Signal (on RDS) |
| Dice | Digital In Car Entertainment |
| DIO | Digital I/O (on EPICS7A) |
| DIV | Divide Divider |
| DL | DiRaNa2 LeafDice |
| DRM | Digital Radio Mondiale |
| DSP | Digital Signal Processor |
| DVD | Digital Video Disc Digital Versatile Disc |
| EBU | European Broadcasting Union |
| EPICS | Economic Parameterized Integrated CoreS |
| ESD | Electrostatic Discharge |
| FIR | Finite Impulse Response |
| FM | Frequency Modulation |
| GPIO | General Purpose I/O |
| I/O | Input/Output |
| I ² C | Inter-IC Communication |

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| Table 46. | Abbreviationscontinued |
|------------------|--|
| Acronym | Description |
| l ² S | Inter-IC Sound (a Philips standard) |
| IAC | Interference Absorption Circuit |
| IBOC | In–Band On–Channel |
| IF | Intermediate Frequency |
| IFADC | Intermediate Frequency Analog-to-Digital Converter |
| IFFC | IF Filter Compensation |
| IFLAG | I Flag (EPICS7A flag) |
| IIS | Inter–IC Sound (any data format) |
| IMODE | Input Flag Mode of EPICS7A |
| IQ | Quadra-tone Signals I and Q |
| IQC | IQ Correction |
| JTAG | Joint Test Action Group |
| kSa/s | kilo Samples per second |
| LFLAG | L Flag (EPICS7A flag) |
| LMS | Least Mean Square |
| LSB | Least Significant Bit |
| MPI | MicroProcessor Interface |
| MPX | Frequency MultiPleXed signal (audio/data) |
| MSa/s | Mega Samples per second |
| MSB | Most Significant Bit |
| MSEL | Selection for the M-divider |
| NSEL | Selection for the N-divider |
| NLMS | Normalized Least Mean Square |
| NZIF | Near Zero IF |
| PCB | Printed Circuit Board |
| PDC | Primary Decimation Chain |
| PLL | Phase Lock Loop |
| PMOS | Positive channel Metal Oxide Semiconductor |
| RBDS | Radio Broadcast Data System Radio Broadcast Data Signals |
| RDS | Radio Data System |
| RDDA | RDS Data Output Radio Digital DAta |
| RDCL | RDS CLock output (master mode) RDS CLock input (slave mode) |
| RGP | Radio General Purpose |
| RGP DAC | Radio General Purpose Digital-to-Analog Converter |
| ROM | Read Only Memory |
| SCL | Serial Clock (I ² C line) |
| SDA | Serial Data (I ² C line) |
| SDSP | Sample Rate Converter DSP |

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| Table 46. | Abbreviations continued |
|-----------|---|
| Acronym | Description |
| SFLAG | Sync Flag |
| SPDIF | Sony/Philips Digital Interface Format |
| SRC | Sample Rate Converter |
| TDSP | Tuner DSP |
| THD | Total Harmonic Distortion |
| TTL | Transistor-Transistor Logic |
| VDD | Positive supply voltage |
| VDDA | Positive supply voltage (analog) |
| VDDE | Positive supply (peripheral cells) |
| VIA | A link between two layers of a PCB |
| VREFAD | Reference voltage for ADC |
| VSS | Negative supply voltage |
| VSSA | Negative supply voltage (analog) |
| VSSE | Ground supply (peripheral cells) |
| WB | Weather Band |
| WDOG | WatchDog |
| WS | Word-Size |
| XRAM | X (typically for DSP data) Random Access Memory |
| YRAM | Y (typically for DSP coefficients) Random Access Memory |
| YROM | Y (typically for DSP coefficients) Read Only Memory |
| ZIF | Zero IF |

17. References

- [1] SAF7741HV Radio User Manual
- [2] SAF7741HV User Manual
- [3] SAF7741HV I²C Memory Map
- [4] SAF7741HV DIO Map
- [5] Official Philips I²S Standard Document (available from NXP Semiconductors, International Marketing and Sales)
- [6] Digital Audio Interface specification (IEC60958-1 Edition 2, Part 1: General Part and IEC60958-3 Edition 2, Part 3: Consumer Applications)

18. Revision history

| Table 47. Revisi | on history | | | | |
|-------------------------------------|---------------------|--------------------------|-----------------------------------|-----------------------|-----------------------|
| Document ID | Release Date | Data Sheet Status | Change Notice | Document Number | Supersedes |
| DAF7741HV_7 | 20100428 | Product data sheet | - | 9397 750 | SAF7741HV_6 |
| Modifications | | | | | |
| Specification s | status changed to F | Product data sheet | | | |
| DAF7741HV_6 | 20080712 | Objective data sheet | - | 9397 750 | SAF7741HV_5 |
| Modifications | | | | | |
| Figure 42 has | been updated | | | | |
| SAF7741HV_5 | 20080509 | Objective data sheet | - | 9397 750 | SAF7741HV_4 |
| Modifications | | | | | |
| Some minor u | pdates and correct | tions. | | | |
| SAF7741HV_4 | 20080214 | Objective data sheet | - | 9397 750 | SAF7741HV_3 |
| Modifications | | | | | |
| Updated the s | ingle-tuner SAF77 | 41 and TEF7000 applicat | ion diagram (<mark>Figure</mark> | <u>• 40</u>). | |
| SAF7741HV_3 | 20080125 | Objective data sheet | - | 9397 750 | SAF7741HV_2 |
| Modifications | | | | | |
| Some minor c | orrections. | | | | |
| SAF7741HV_2 | 20080117 | Objective data sheet | - | 9397 750 | SAF7741HV_1 |
| Modifications | | | | | |
| The format of | this user manual h | as been redesigned to co | mply with the new i | dentity guidelines of | of NXP Semiconductors |
| Legal texts had | ve been adapted to | o the new company name | where appropriate | | |
| Updated to ind | corporate changes | since initial release. | | | |

SAF7741HV_1 20061031 Objective data sheet - 9397 750 -

Contact information

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